

**ABSTRACT**

This user guide describes the operational use of the TPS38700Q1EVM evaluation module (EVM) as a reference design for engineering demonstration and evaluation of the [TPS38700-Q1 Multichannel I2C Programmable Voltage Sequencer](#). This guide contains the EVM schematic, bill of materials (BOM), assembly drawing, and top and bottom board layouts.

Table of Contents

| | |
|---|-----------|
| 1 Introduction | 3 |
| 1.1 Related Documentation..... | 4 |
| 1.2 TPS38700-Q1 Applications..... | 4 |
| 2 Schematic, Bill of Materials, and Layout | 5 |
| 2.1 TPS38700Q1EVM Schematic..... | 6 |
| 2.2 TPS38700Q1EVM Bill of Materials..... | 8 |
| 2.3 Layout and Component Placement..... | 10 |
| 2.4 Layout..... | 10 |
| 3 EVM Connectors | 17 |
| 3.1 EVM Test Points..... | 17 |
| 3.2 EVM Jumpers..... | 18 |
| 4 EVM Setup and Operation | 19 |
| 4.1 Setup and GUI Installations..... | 19 |
| 4.2 GUI..... | 25 |
| 4.3 Quick Start..... | 28 |
| 5 Revision History | 32 |

List of Figures

| | |
|--|----|
| Figure 1-1. TPS38700Q1EVM Board Top..... | 3 |
| Figure 1-2. TPS38700Q1EVM Board Bottom..... | 4 |
| Figure 2-1. TPS38700Q1EVM Schematic 1 of 2..... | 6 |
| Figure 2-2. TPS38700Q1EVM Schematic 2 of 2..... | 7 |
| Figure 2-3. Component Placement—Top Assembly..... | 10 |
| Figure 2-4. Component Placement—Bottom Assembly..... | 11 |
| Figure 2-5. Layout—Top..... | 12 |
| Figure 2-6. Layout—Bottom..... | 13 |
| Figure 2-7. Top Layer..... | 14 |
| Figure 2-8. Bottom Layer..... | 15 |
| Figure 2-9. Top Solder Mask..... | 16 |
| Figure 3-1. Jumper Settings..... | 18 |
| Figure 4-1. EVM Connections for Testing EN1 and EN2..... | 20 |
| Figure 4-2. Welcome Setup Window..... | 21 |
| Figure 4-3. Setup License Agreement Window..... | 21 |
| Figure 4-4. Setup Destination Window..... | 22 |
| Figure 4-5. Setup Window - Start Menu Selection..... | 22 |
| Figure 4-6. Setup Window - Additional Tasks..... | 23 |
| Figure 4-7. Setup Installation Window..... | 23 |
| Figure 4-8. Installation Complete Window..... | 24 |
| Figure 4-9. Main GUI Screen..... | 25 |
| Figure 4-10. System Config..... | 25 |
| Figure 4-11. Sequence Config..... | 26 |
| Figure 4-12. Watchdog Config..... | 26 |

| | |
|---|----|
| Figure 4-13. Alarms Config..... | 27 |
| Figure 4-14. Registers..... | 27 |
| Figure 4-15. Fusion Welcome Window..... | 28 |
| Figure 4-16. Fusion Scan Window..... | 29 |
| Figure 4-17. Fusion Scan Selection Window..... | 29 |
| Figure 4-18. Fusion Scan Window - Scanning for TPS38700Q1EVM..... | 30 |
| Figure 4-19. Fusion Scan Window - Scan for TPS38700Q1EVM Completed..... | 30 |
| Figure 4-20. TPS38700 GUI Window - Sequence Config Tab..... | 31 |
| Figure 4-21. Expected Output Signal..... | 31 |

List of Tables

| | |
|--|----|
| Table 2-1. BOM..... | 8 |
| Table 3-1. Test Points..... | 17 |
| Table 3-2. List of On-board Jumpers..... | 18 |

Trademarks

All trademarks are the property of their respective owners.

1 Introduction

The TPS38700Q1EVM is an evaluation module (EVM) for the [TPS38700-Q1 Multichannel I2C Programmable Voltage Sequencer](#). Test points are provided to give the user additional access, if needed, for oscilloscope or multi-meter measurements.

The TPS38700Q1EVM comes pre-populated with TPS38700C03NRGERQ1. This option offers NEM_PD pin which allow the system to issue an emergency power down while also being able to sequence up to ten different devices all with a precise predefined sequence. The device also offers the option of battery backup power, a precise 32.768 kHz clock, and the ability to communicate faults via I2C. ACT and SLEEP pins allow for the device to change state depending on the logic level present on each. The NIRQ pin serves as an interrupt flag to alert the system to possible faults, and the NRST pin asserts logic high under reset condition.

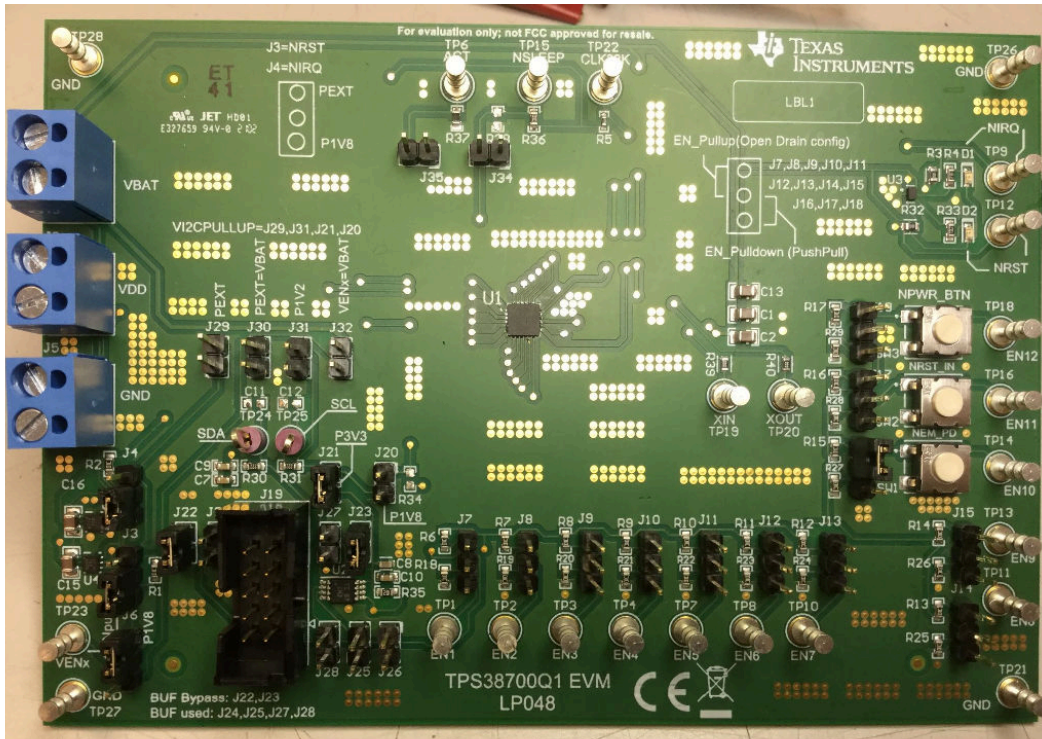


Figure 1-1. TPS38700Q1EVM Board Top

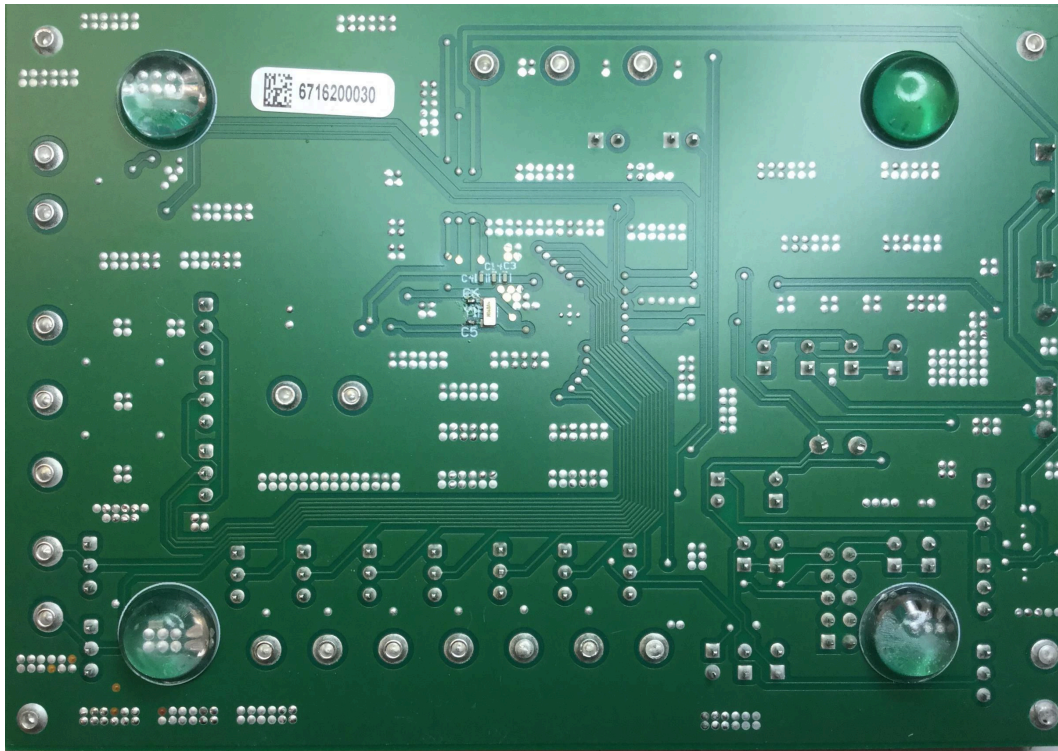


Figure 1-2. TPS38700Q1EVM Board Bottom

1.1 Related Documentation

Datasheet: [TPS38700-Q1 Multichannel I2C Programmable Voltage Sequencer](#)

1.2 TPS38700-Q1 Applications

- [Advanced Driver Assistance System \(ADAS\)](#)
- [Medical robotics](#)
- [Industrial robotics](#)

2 Schematic, Bill of Materials, and Layout

This section provides a detailed description of the TPS38700Q1EVM schematic, bill of materials (BOM), and layout.

2.1 TPS38700Q1EVM Schematic

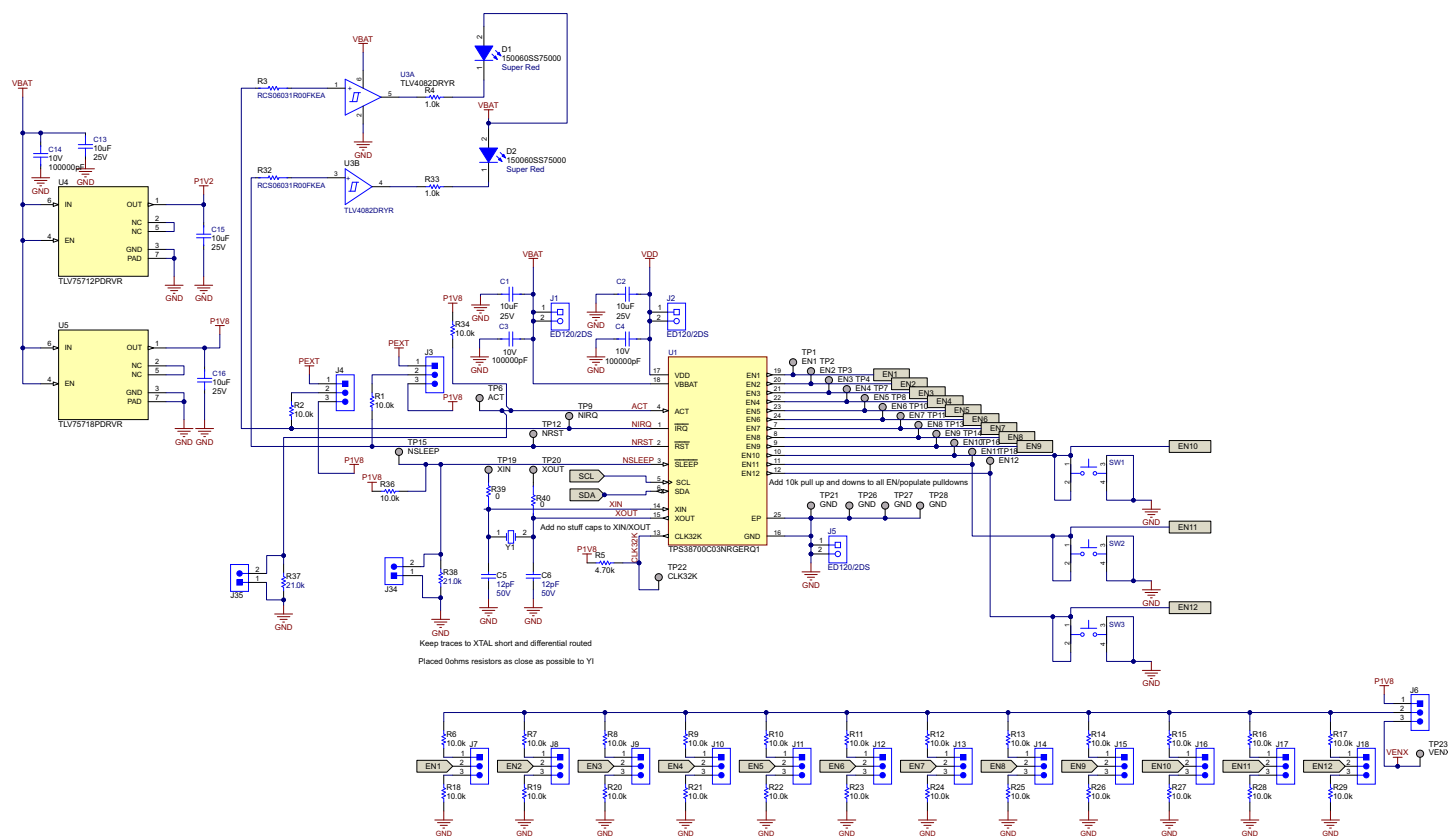


Figure 2-1. TPS38700Q1EVM Schematic 1 of 2

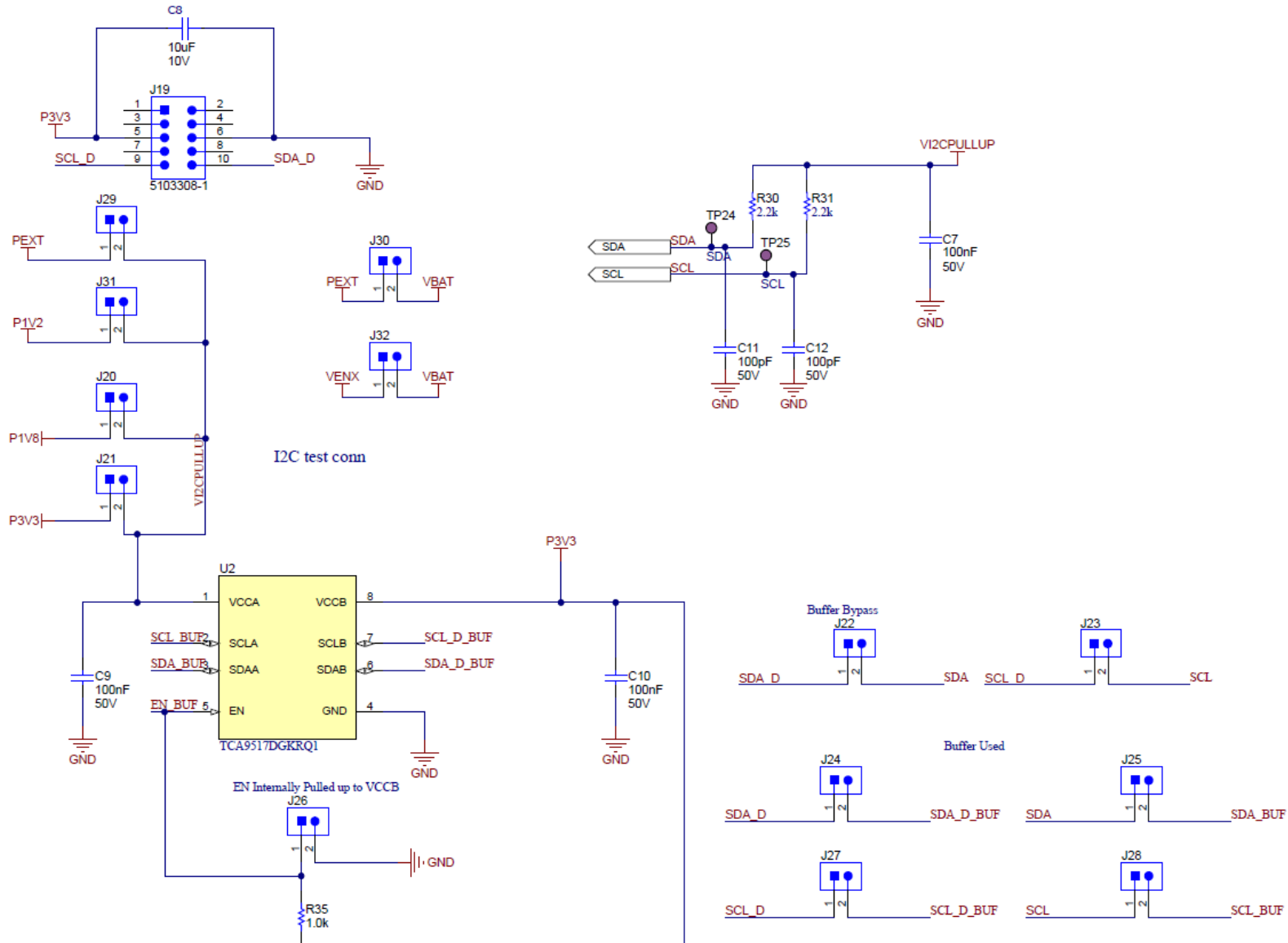


Figure 2-2. TPS38700Q1EVM Schematic 2 of 2

2.2 TPS38700Q1EVM Bill of Materials

Table 2-1. BOM

| DESIGNATOR | QTY | VALUE | DESCRIPTION | PACKAGE REFERENCE | PART NUMBER | MANUFACTURER |
|--|-----|-----------------|---|-------------------|---------------------|---------------------|
| PCB | 1 | | Printed Circuit Board | | LP048 | Any |
| C1, C2, C13, C15, C16 | 5 | 10 μ F | 10 μ F \pm 10% 25 V Ceramic Capacitor X7S 0805 (2012 Metric) | 0805 | C2012X7S1E106K125AC | TDK |
| C3, C4, C14 | 3 | 0.1 μ F | 0.1 μ F \pm 10% 10 V Ceramic Capacitor X7R 0402 (1005 Metric) | 0402 | 885012205018 | Würth Electronics |
| C5, C6 | 2 | 12 pF | CAP, CERM, 12 pF, 50 V, +/- 5%, COG/NPO, 0201 | 0201 | GRM0335C1H120JA01D | MuRata |
| C7, C9, C10 | 3 | 0.1 μ F | CAP, CERM, 0.1 μ F, 50 V, +/- 10%, X7R, 0603 | 0603 | 06035C104KAT2A | AVX |
| C8 | 1 | 10 μ F | 10 μ F \pm 10% 10 V Ceramic Capacitor X5R 0603 (1608 Metric) | 0603 | C1608X5R1A106K080AC | TDK |
| C11, C12 | 2 | 100 pF | CAP, CERM, 100 pF, 50 V, +/- 5%, COG/NPO, 0603 | 0603 | 06035A101JAT2A | AVX |
| D1, D2 | 2 | Red | LED, Super Red, SMD | SMD | 150060SS75000 | Würth Elektronik |
| FID1, FID2, FID3 | 3 | | Fiducial mark. There is nothing to buy or mount. | | N/A | N/A |
| H1, H2, H3, H4 | 4 | | Bumpon, Hemisphere, 0.44 X 0.20, Clear | | SJ-5303 (CLEAR) | 3M |
| J1, J2, J5 | 3 | | Terminal Block, 5.08 mm, 2x1, Brass, TH | 2x1 TH | ED120/2DS | On-Shore Technology |
| J3, J4, J6, J7, J8, J9, J10, J11, J12, J13, J14, J15, J16, J17, J18 | 15 | | Header, 100mil, 3x1, Gold, TH | 3x1 TH | TSW-103-07-G-S | Samtec |
| J19 | 1 | | Header (shrouded), 100mil, 5x2, Gold, TH | 5x2 TH | 5103308-1 | TE Connectivity |
| J20, J21, J22, J23, J24, J25, J26, J27, J28, J29, J30, J31, J32, J34, J35 | 15 | | Header, 100mil, 2x1, Gold, TH | 2x1 TH | TSW-102-07-G-S | Samtec |
| LBL1 | 1 | | Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll | | THT-14-423-10 | Brady |
| R1, R2, R6, R7, R8, R9, R10, R11, R12, R13, R14, R15, R16, R17, R18, R19, R20, R21, R22, R23, R24, R25, R26, R27, R28, R29 | 26 | 10.0 k Ω | RES, 10.0 k Ω , 1%, 0.1 W, 0603 | 0603 | RC0603FR-0710KL | Yageo |
| R3, R32 | 2 | 1 Ω | 1 Ω \pm 1% 0.25 W, 1/4 W Chip Resistor 0603 (1608 Metric) Automotive AEC-Q200, Pulse Withstanding Thick Film | 0603 | RCS06031R00FKEA | Vishay |
| R4, R33 | 2 | 1.0 k Ω | RES, 1.0 k Ω , 5%, 0.1 W, 0603 | 0603 | RC0603JR-071KL | Yageo |
| R5 | 1 | 4.7 k Ω | RES, 4.70 k Ω , 1%, 0.063 W, 0402 | 0402 | CRG0402F4K7 | TE Connectivity |
| R30, R31 | 2 | 2.2 k Ω | RES, 2.2 k Ω , 5%, 0.1 W, 0603 | 0603 | RC0603JR-072K2L | Yageo |
| R34, R36 | 2 | 10.0 k Ω | RES, 10.0 k Ω , 1%, 0.1 W, 0603 | 0603 | RCG060310K0FKEA | Vishay Draloric |

Table 2-1. BOM (continued)

| DESIGNATOR | QTY | VALUE | DESCRIPTION | PACKAGE REFERENCE | PART NUMBER | MANUFACTURER |
|--|-----|-----------------|---|-------------------|----------------------------|-------------------|
| R35 | 1 | 1.0 k Ω | RES, 1.0 k Ω , 5%, 0.1 W, AEC-Q200 Grade 0, 0603 | 0603 | CRCW06031K00JNEA | Vishay-Dale |
| R37, R38 | 2 | 21.0 k Ω | RES, 21.0 k Ω , 1%, 0.1 W, 0603 | 0603 | RC0603FR-0721K1L | Yageo |
| R39, R40 | 2 | 0 Ω | 0 Ω Jumper 0.1 W, 1/10 W Chip Resistor 0603 (1608 Metric) Automotive AEC-Q200 Thick Film | 0603 | ERJ-3GEY0R00V | Panasonic |
| SW1, SW2, SW3 | 3 | | Switch Tactile N.O. SPST Round Button J-Bend 32VAC 32 VDC 1VA 100000Cycles 3N SMD Tube/T/R | SMD | KT11P3JM34LFS | C&K Components |
| TP1, TP2, TP3, TP4, TP6, TP7, TP8, TP9, TP10, TP11, TP12, TP13, TP14, TP15, TP16, TP18, TP19, TP20, TP21, TP22, TP23, TP26, TP27, TP28 | 24 | | Terminal, Turret, TH, Triple | TH | 1598-2 | Keystone |
| TP24, TP25 | 2 | | Test Point, Multipurpose, Purple, TH | TH | 5129 | Keystone |
| U2 | 1 | | Automotive, Level-Shifting I2C Bus Repeater, DGK0008A (VSSOP-8) | VSSOP-8 | TCA9517DGKRQ1 | Texas Instruments |
| U3 | 1 | | Dual-Channel, Low-Power Comparator with Integrated Reference (USON) | USON | TLV4082DRYR | Texas Instruments |
| U4 | 1 | | 1 A Low-Quiescent-Current Low-Dropout (LDO) Regulator, DRV0006A (WSON-6) | WSON-6 | TLV75712PDRVR | Texas Instruments |
| U5 | 1 | | 1 A Low-Quiescent-Current Low-Dropout (LDO) Regulator, DRV0006A (WSON-6) | WSON-6 | TLV75718PDRVR | Texas Instruments |
| U1 | 1 | | ASIL-B Multichannel I2C Programmable Voltage Sequencer (VQFN) | VQFN | TPS38700C03NRGERQ1 | Texas Instruments |
| Y1 | 1 | | Crystal, 32.768 kHz, 12.5 pF, SMD | SMD | NX3215SA-32.768K-STD-MUA-8 | NDK |

2.3 Layout and Component Placement

Figure 2-3 and Figure 2-4 show the top and bottom assemblies of the printed circuit board (PCB) to show the component placement on the EVM.

Figure 2-5 and Figure 2-6 show the top and bottom layouts, Figure 2-7 and Figure 2-8 show the top and bottom layers, and Figure 2-9 shows the top solder mask of the EVM.

2.4 Layout

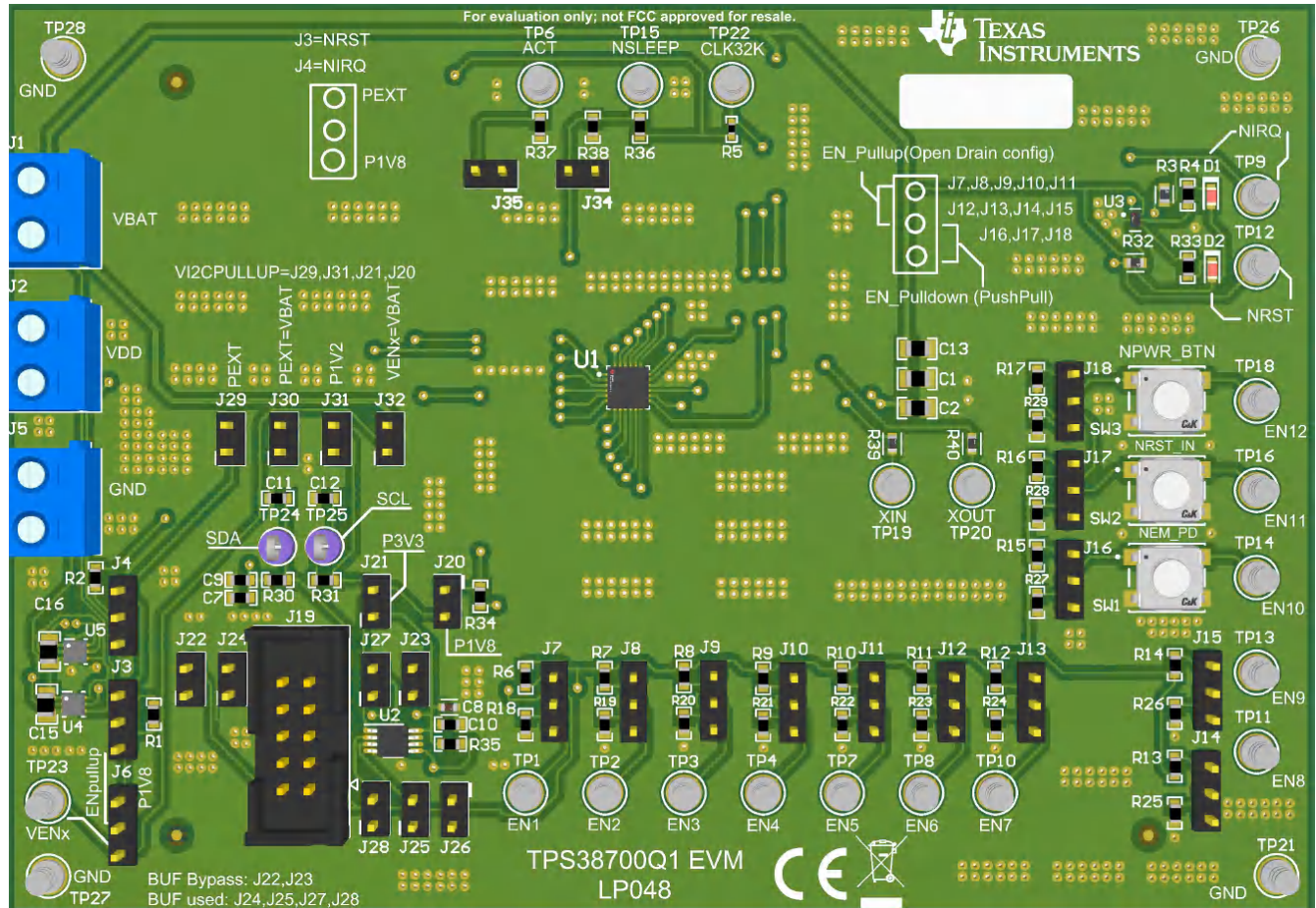


Figure 2-3. Component Placement—Top Assembly

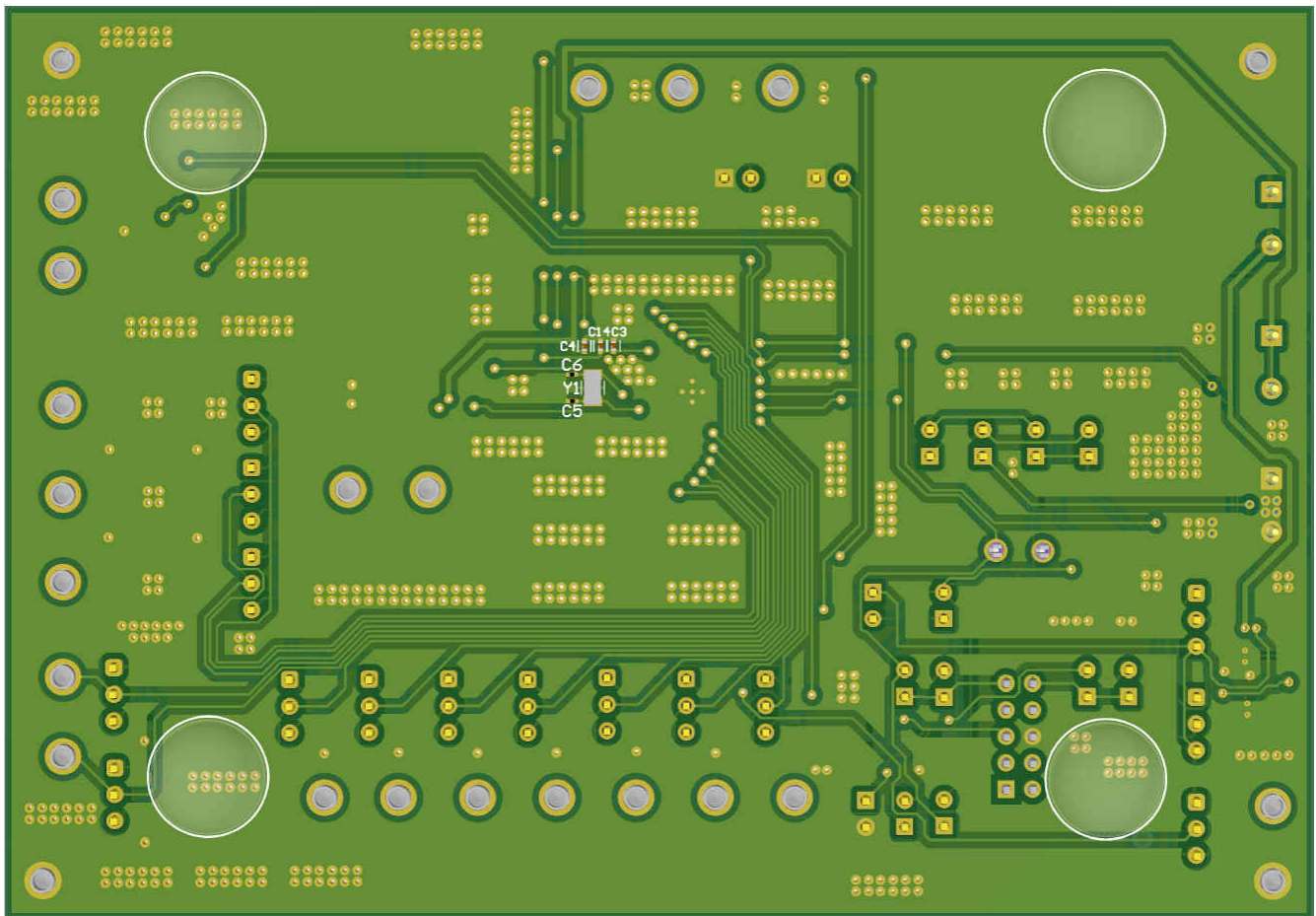


Figure 2-4. Component Placement—Bottom Assembly

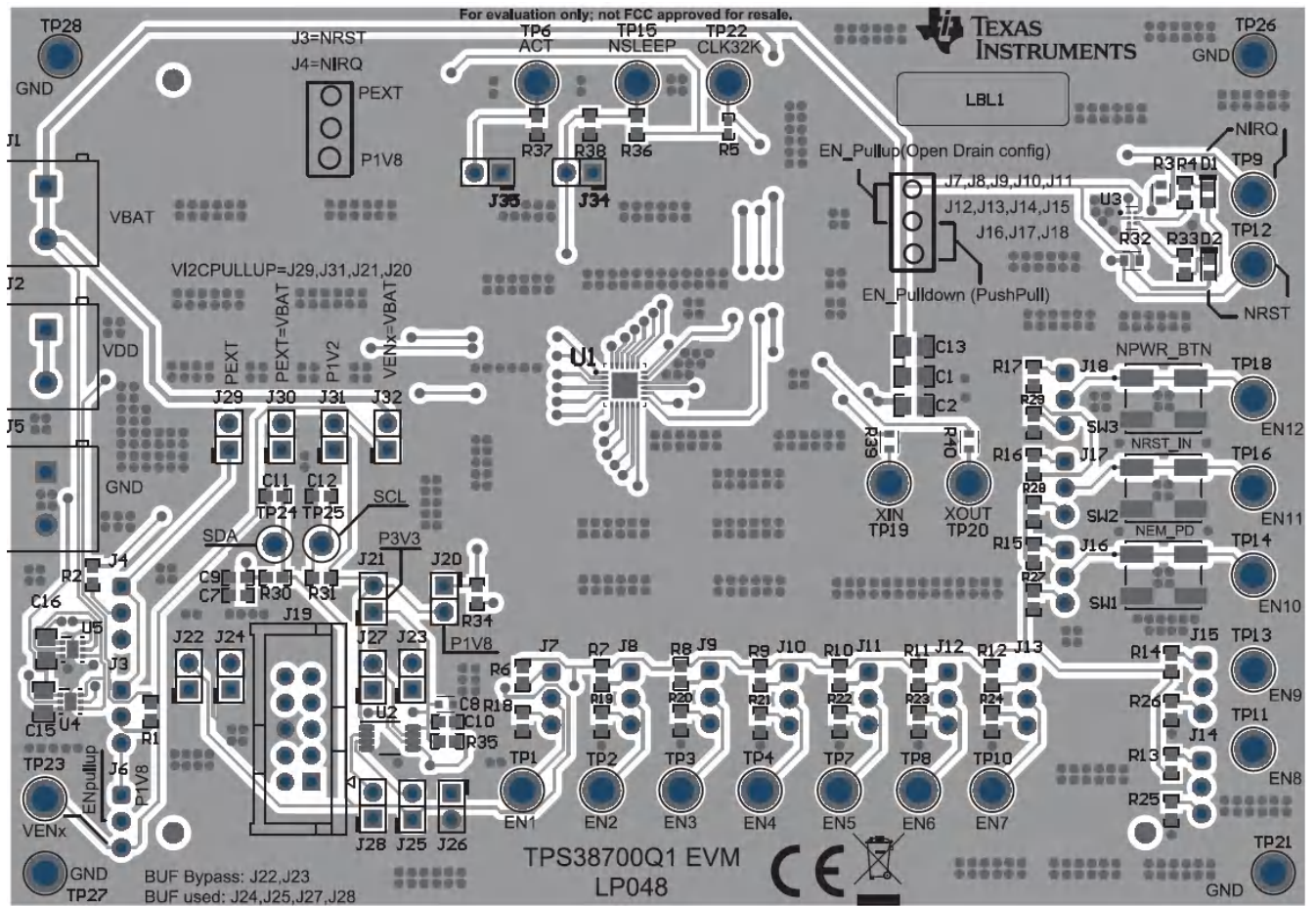


Figure 2-5. Layout—Top

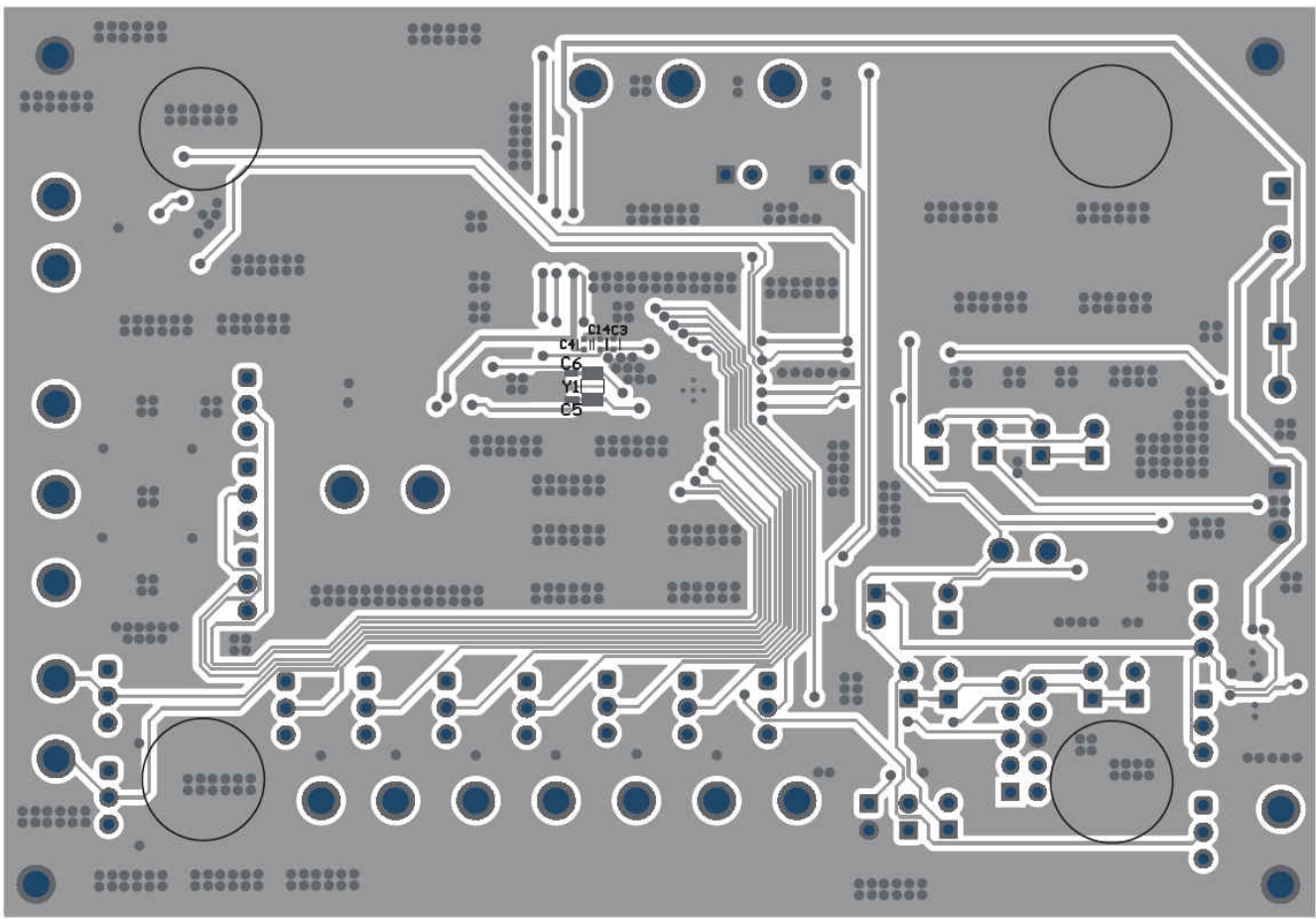


Figure 2-6. Layout—Bottom

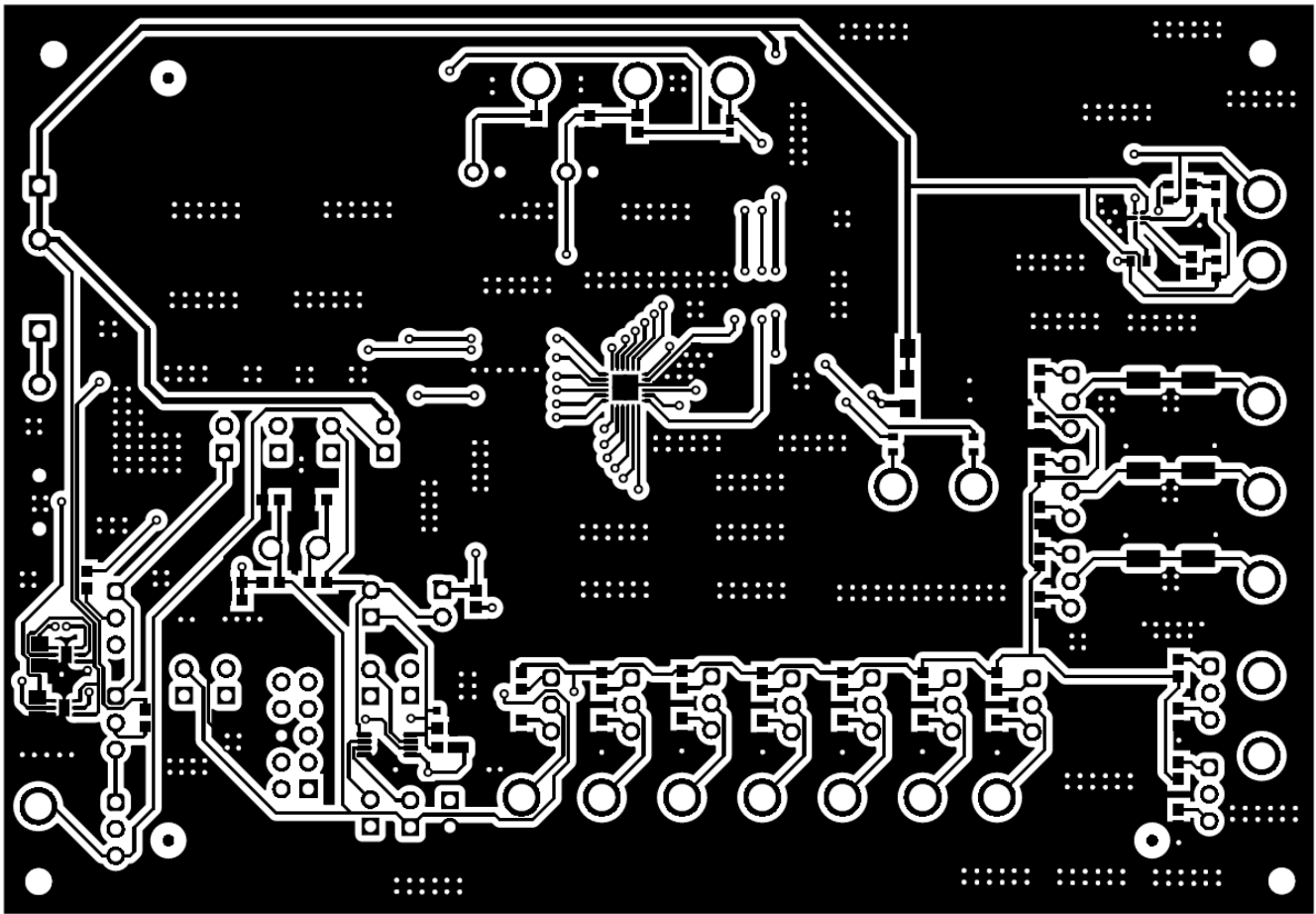


Figure 2-7. Top Layer

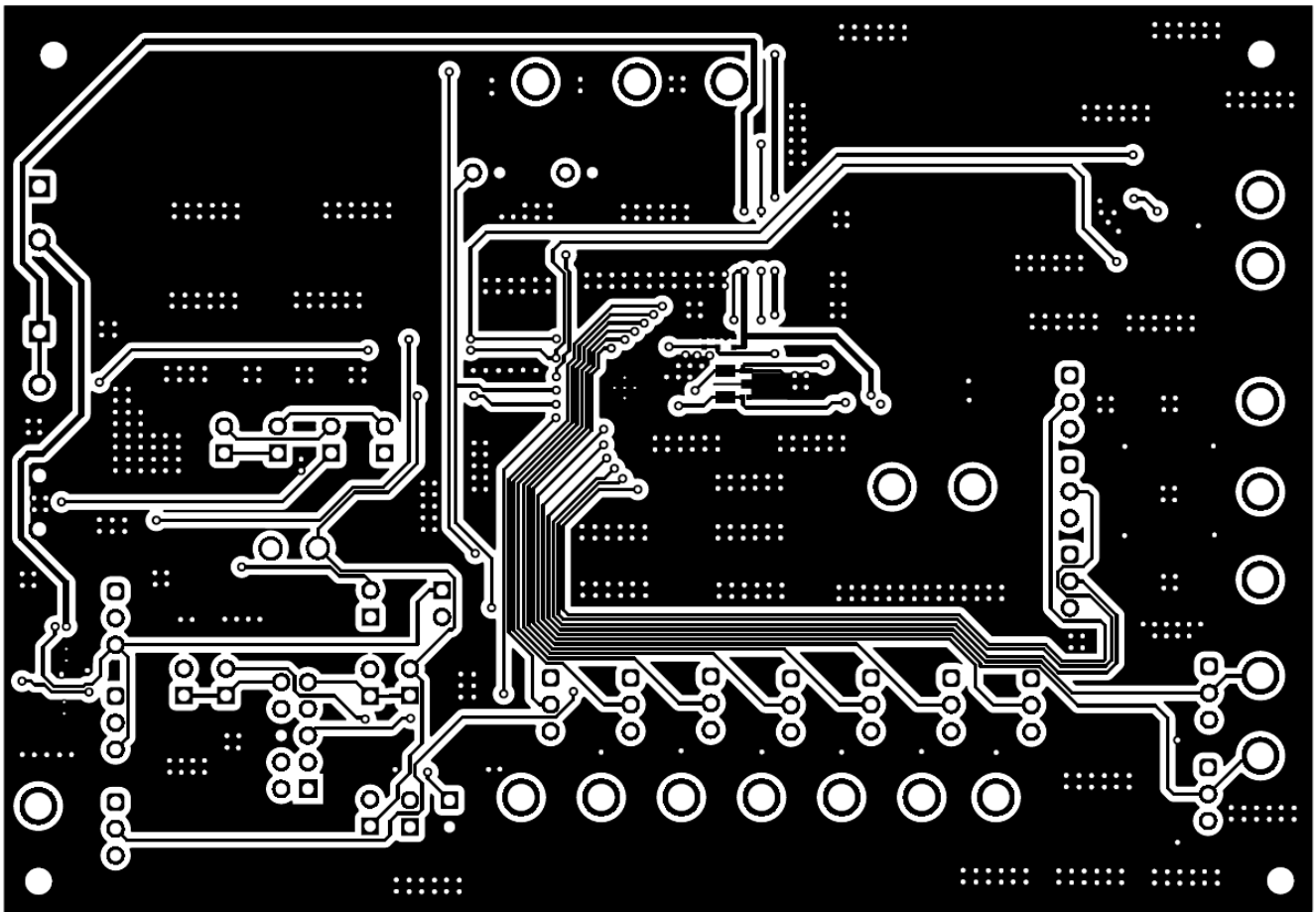


Figure 2-8. Bottom Layer

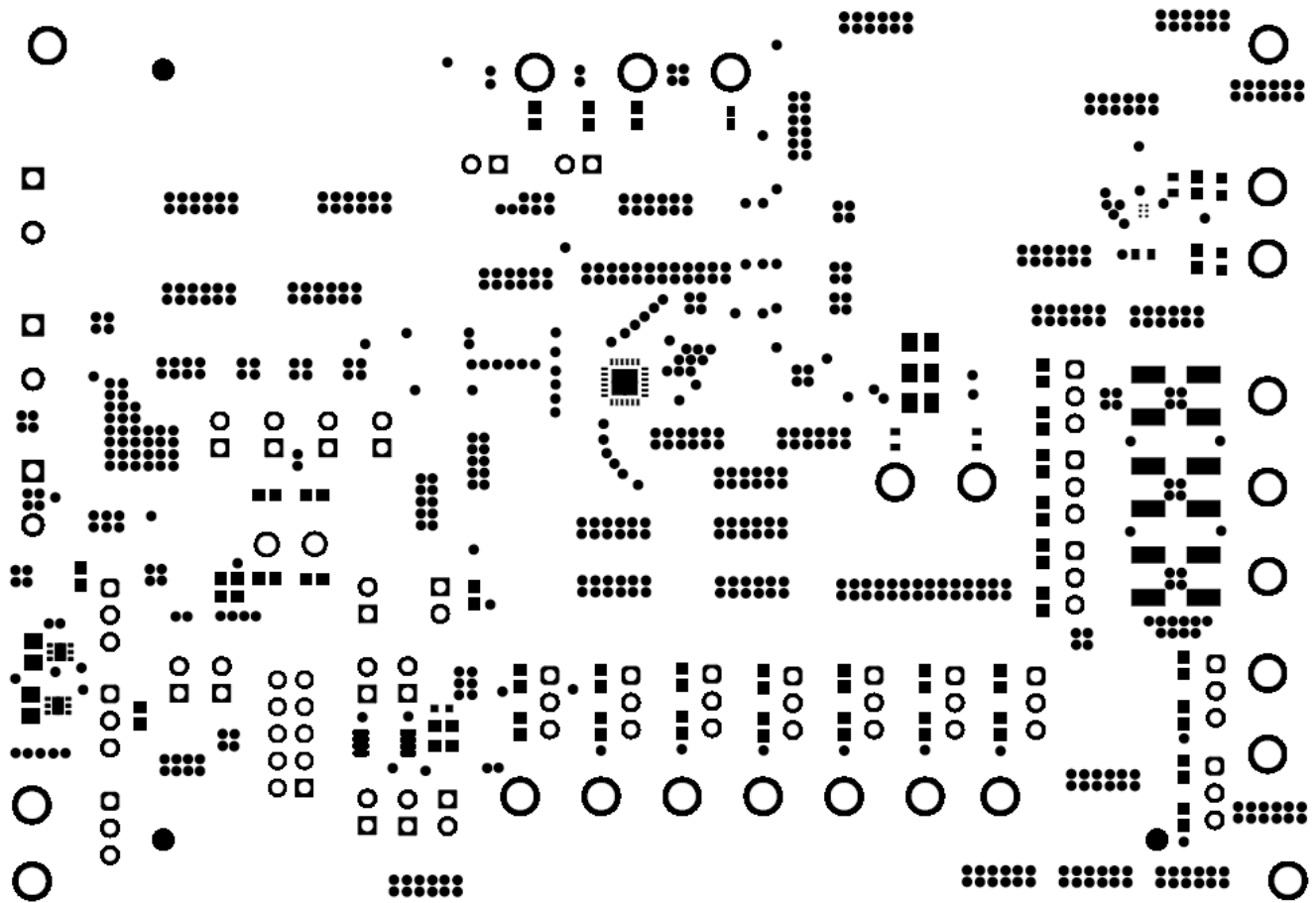


Figure 2-9. Top Solder Mask

3 EVM Connectors

This section describes the connectors, jumpers, and test points on the EVM as well as how to connect, set up, and properly use the EVM. Each device has an independent supply connection, but all grounds are connected on the board.

3.1 EVM Test Points

Table 3-1 lists the EVM test points as well as their functional descriptions. All TPS38700-Q1 pins have a corresponding test point on the EVM. These test points are located close to the pins for more accurate measurements. In addition to the test points listed below, the EVM also has four additional GND test points.

Table 3-1. Test Points

| TEST POINT NUMBER | TEST POINT SILKSCREEN LABEL | FUNCTION | DESCRIPTION |
|-------------------|-----------------------------|---|--|
| TP1 | EN1 | Connection to EN1 pin | Allows the user to monitor the SENSE1 pin |
| TP2 | EN2 | Connection to EN2 pin | Allows the user to monitor the EN2 pin |
| TP3 | EN3 | Connection to EN3 pin | Allows the user to monitor the EN3 pin |
| TP4 | EN4 | Connection to EN4 pin | Allows the user to monitor the EN4 pin |
| TP6 | ACT | Connection to ACT pin | Allows the user to set ACT input |
| TP7 | EN5 | Connection to EN5 pin | Allows the user to monitor the EN5 output |
| TP8 | EN6 | Connection to EN6 pin | Allows the user to monitor the EN6 output |
| TP9 | NIRQ | Connection to NIRQ pin | Allows the user to monitor the NIRQ output |
| TP10 | EN7 | Connection to EN7 pin | Allows the user to monitor the EN7 output |
| TP11 | EN8 | Connection to EN8 pin | Allows the user to monitor the EN8 output |
| TP12 | NRST | Connection to NRST pin | Allows the user to monitor the NRST output |
| TP13 | EN9 | Connection to EN9 pin | Allows the user to monitor the EN9 output |
| TP14 | EN10/NEM_PD | Connection to EN10 pin and Emergency Shutdown pin | Allows the user to monitor the EN10 output |
| TP15 | SLEEP | Connection to SLEEP pin | Allows the user to set SLEEP input |
| TP16 | EN11/NRST_IN | Connection to EN11 pin and Reset In | Allows the user to monitor the EN11 output |
| TP18 | EN12/NPWR_BTN | Connection to EN12 pin and Power Button | Allows the user to monitor the EN12 output |
| TP21 | GND | GND for EVM | GND for EVM |
| TP22 | CLK32K | Connection to CLK32K pin | Allows the user to monitor the CLK32K output |
| TP23 | VENx | Connection to External Voltage | Allows the user to connect to an external voltage for pulling up enable pins |
| TP26 | GND | GND for EVM | GND for EVM |
| TP27 | GND | GND for EVM | GND for EVM |
| TP28 | GND | GND for EVM | GND for EVM |

3.2 EVM Jumpers

Table 3-2 lists the jumpers on the TPS38700Q1EVM. As ordered, the EVM will have sixteen (16) jumpers installed. Figure 3-1 is provided as visual aid.

Table 3-2. List of On-board Jumpers

| JUMPER | DEFAULT JUMPER CONFIGURATION | DESCRIPTION |
|---------------------|------------------------------|---|
| J1 | VBAT | For connecting VBAT power to the EVM |
| J2 | VDD | For connecting VDD power to the EVM |
| J3 & J4 | Shunt to bottom position | For connecting NRST and NIRQ to P1V8 or PEXT (Any external power) |
| J5 | GND | For connecting GND to the EVM |
| J6 | P1V8 | For pulling- up ENABLE pins to P1V8 or VENX (Any external voltage) |
| J7 - J18 | No connect | For pulling-up or down ENABLE pins (Only for open-drain configuration)/No connection for push-pull configuration |
| J16 | Shunt to top position | For pulling-up EN10 pin to P1V8. |
| J19 | Connect | For connecting the EVM to TI's USB Interface Adapter |
| J20, J29, & J31 | No connect | For connecting the on-board buffer to either P1V8, PEXT or P1V2. Only shunt one of these jumpers when using the buffer. Please remove the shunt of J21 when using one of these jumpers. |
| J21 | Shunt | For connecting the on-board buffer IC to P3V3 |
| J22 & J23 | Shunt | For I2C lines to bypass buffer. |
| J24, J25, J27 & J28 | No connect | For I2C lines to use the on-board buffer. |
| J30 | No connect | For connecting VBAT to PEXT |
| J32 | No connect | For connecting VENX to VBAT |
| J34 & J35 | No connect | For manually pulling down NSLEEP and ACT pins |

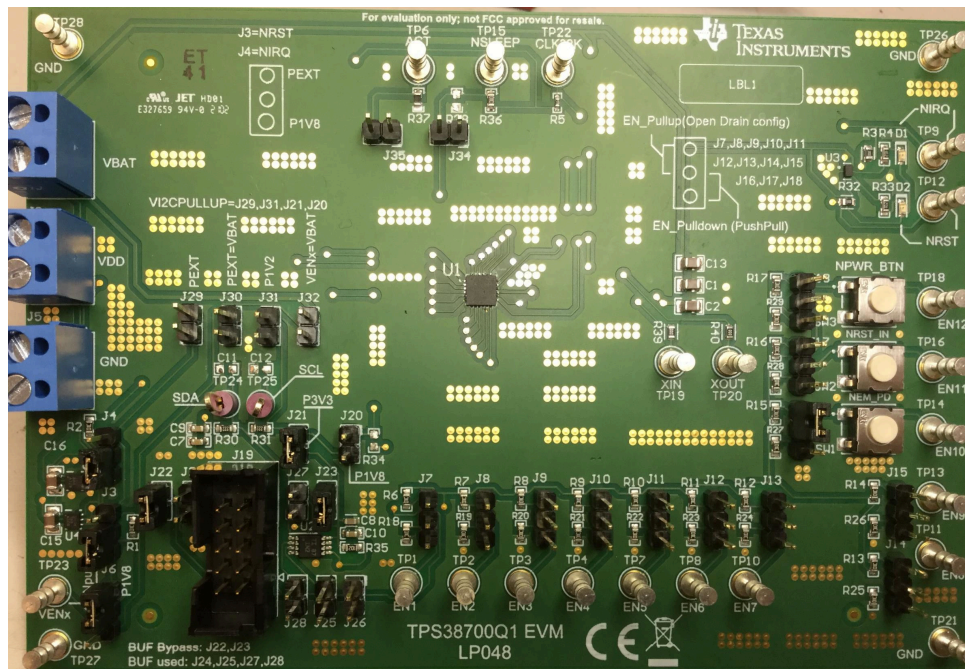


Figure 3-1. Jumper Settings

4 EVM Setup and Operation

This section describes the functionality and operation of the TPS38700Q1EVM. Refer to the [TPS38700-Q1 Multichannel I2C Programmable Voltage Sequencer](#) data sheet for details on the electrical characteristics of the device.

The TPS38700Q1EVM comes pre-populated with the TPS38700C03NRGERQ1. The EVM is capable of many different configurations in order to fully evaluate the functionality of all the TPS38700-Q1 device variants. The default configuration of the EVM Jumpers is mentioned in the [Table 3-2](#). The TPS38700Q1EVM comes populated with I2C bus repeater, comparators, LDO, 32.768 kHz crystal and TPS38700C03NRGERQ1 programmable voltage sequencer.

The TPS38700Q1EVM also provides an option to apply a separate pull-up voltage to any of the ENABLE pins by changing the position of jumper J6 to VENx and connecting the pull-up voltage to test points TP23.

Equipment Needed

- TPS38700Q1EVM
- TI's USB Interface Adapter (with ribbon cable)
- Power Supply (3.3 V)
- Function Generator (provide pulse input for evaluation)
- Multi-channel Oscilloscope (review evaluation waveforms)
- Jumper Cables (additional evaluation)

4.1 Setup and GUI Installations

Follow the steps below for EVM connections and GUI installation:

1. Connect VBAT (J1) and VDD (J2) to 3.3 V from the power supply.
2. Connect GND (J5) to ground from the power supply.
3. Make sure the jumpers are connected as per the guidelines in the [Table 3-2](#).
4. Power on the power supply briefly to check if the voltage is at 3.3 V and the quiescent current is at 10 mA. Once reviewed, power down the power supply.
5. Connect the Oscilloscope's channel 1 to TP1, channel 2 to TP2, and channel 3 to TP6.
6. Connect the function generator to TP6.
7. Connect the TI's USB Interface Adapter to J19 using a ribbon cable.
8. Connect the TI's USB Interface Adapter to the computer using the USB.
9. Final connections should look similar to [. Figure 4-1](#).

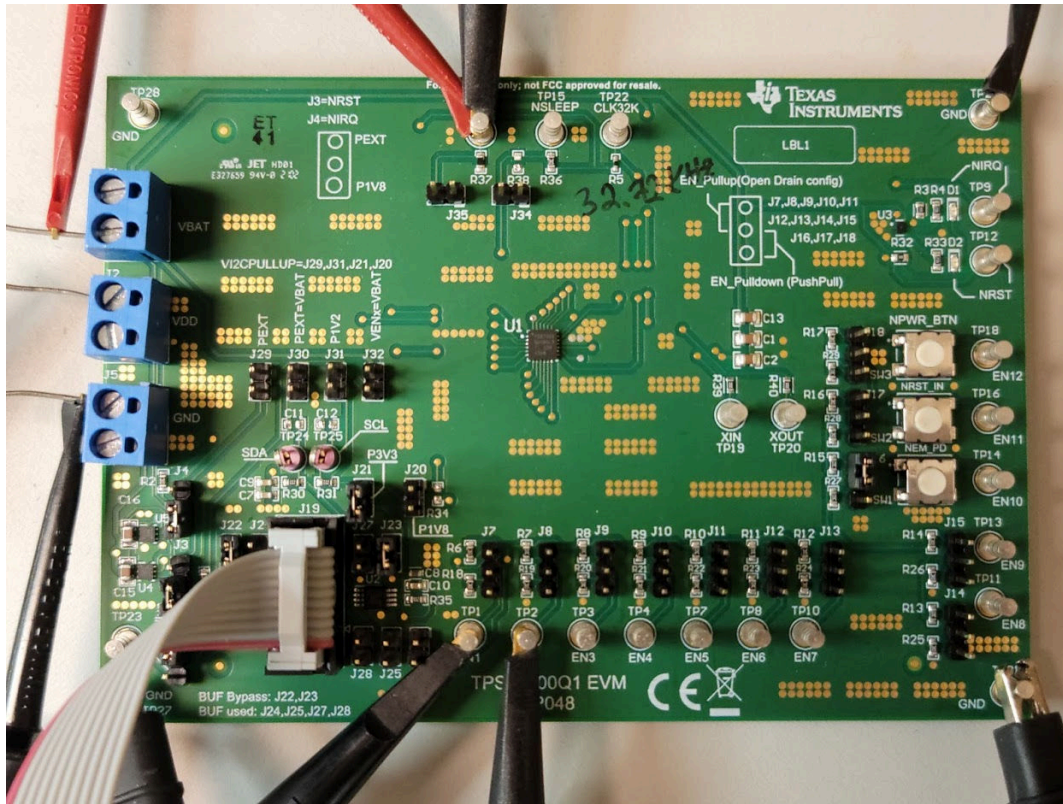


Figure 4-1. EVM Connections for Testing EN1 and EN2

10. Install the GUI.
 - a. Download the [Fusion Digital Power Designer](#) Platform GUI for TPS38700Q1EVM
 - b. Open the downloaded file.
 - c. In the Welcome Wizard window, click Next.

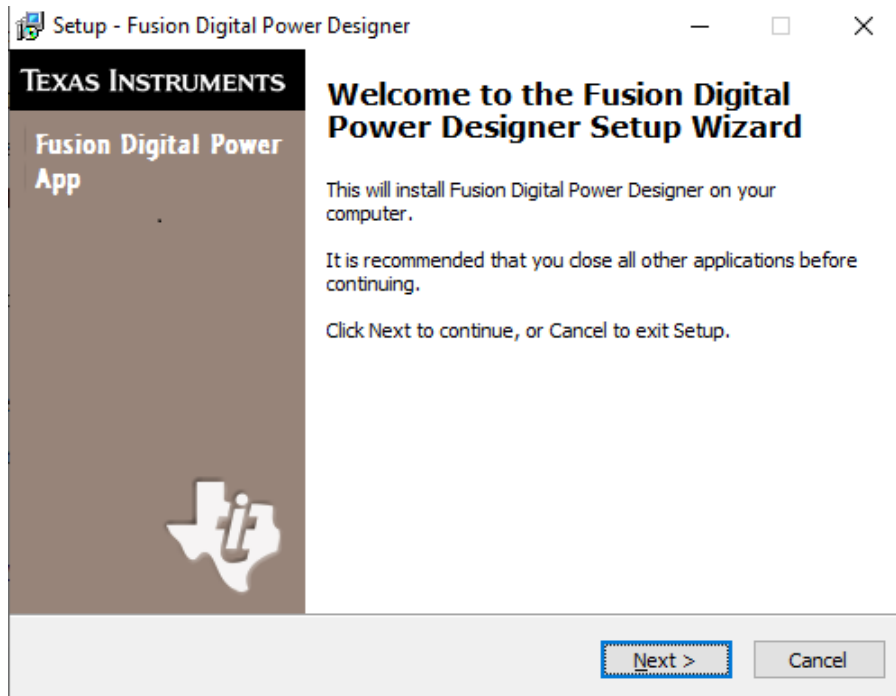


Figure 4-2. Welcome Setup Window

- d. Accept the license agreement and then click Next.

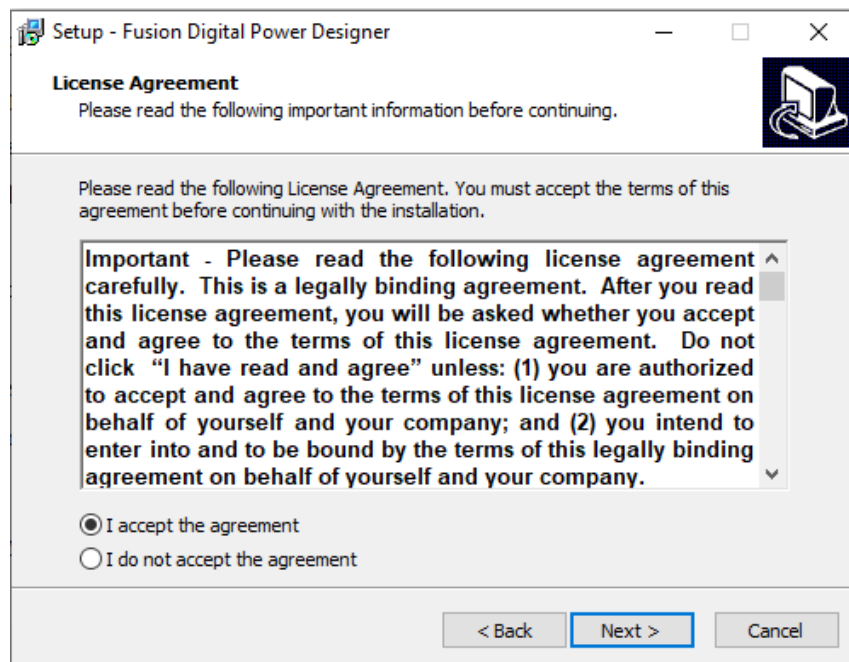


Figure 4-3. Setup License Agreement Window

- e. The default destination folder works best. Click Next.

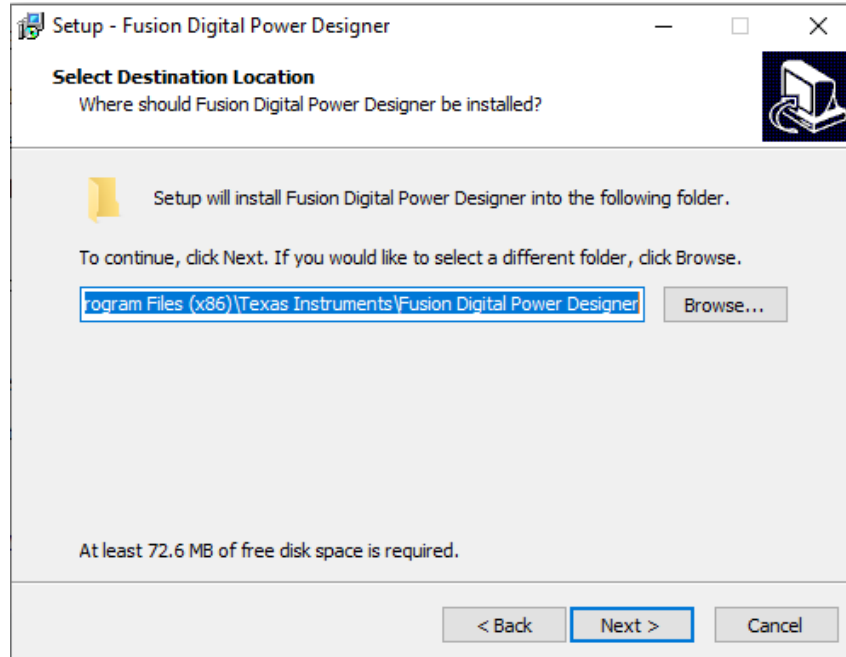


Figure 4-4. Setup Destination Window

- f. Click Next for the Select Start Menu Folder option.

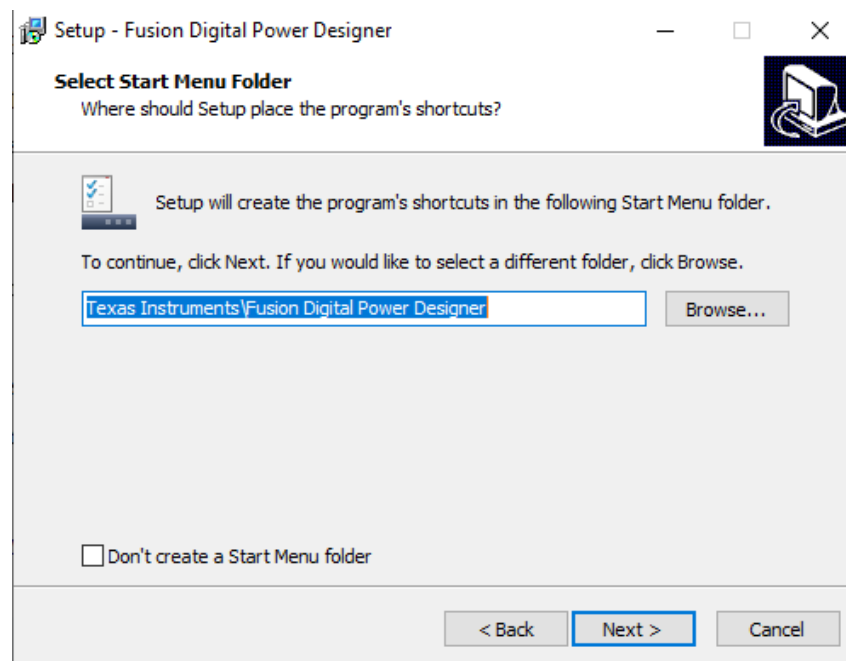


Figure 4-5. Setup Window - Start Menu Selection

- g. There is no need to install additional options for this EVM. Click Next.

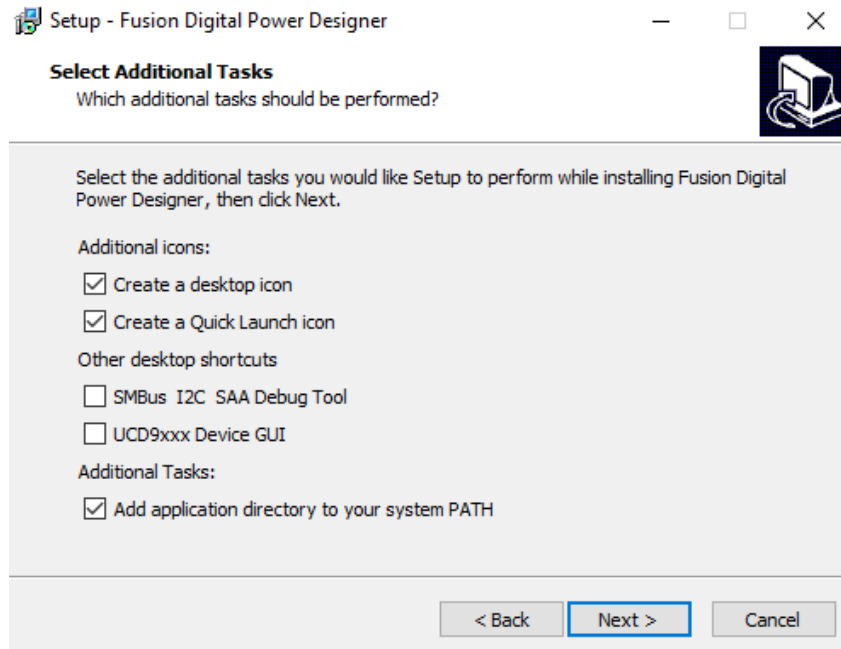


Figure 4-6. Setup Window - Additional Tasks

- h. Finally click Install to install the Fusion software.

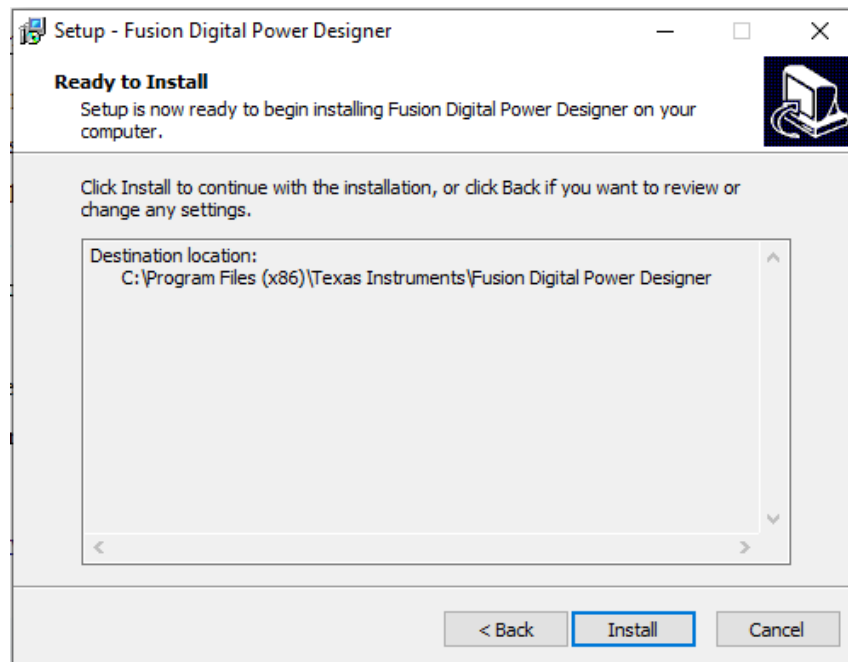


Figure 4-7. Setup Installation Window

- i. Click on Finish to complete the installation setup and launch the software.

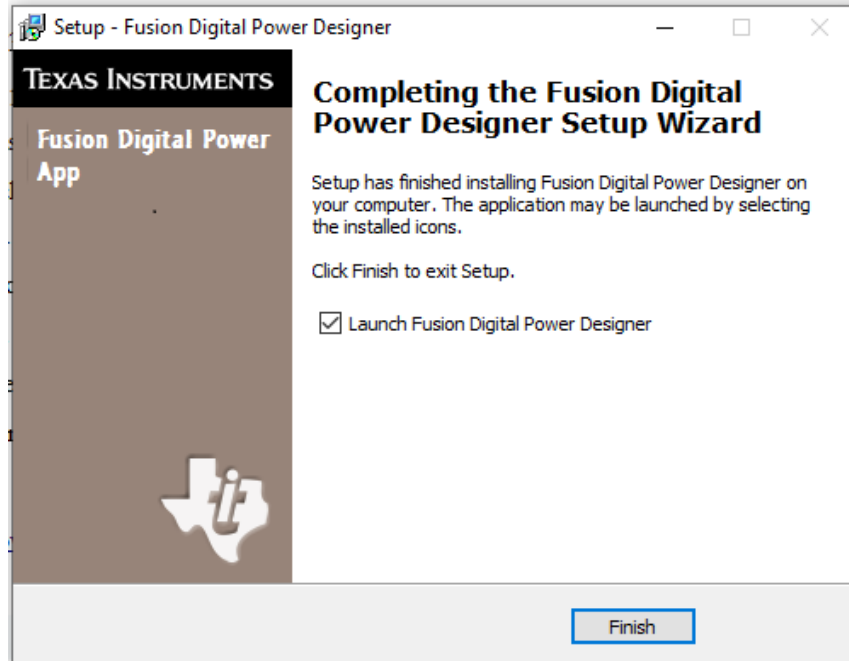


Figure 4-8. Installation Complete Window

4.2 GUI

This section shows the graphical user interface (GUI) the user will use to interact with the EVM. Refer to the [TPS38700-Q1 Multichannel I2C Programmable Voltage Sequencer](#) datasheet for details on the register description of the device.

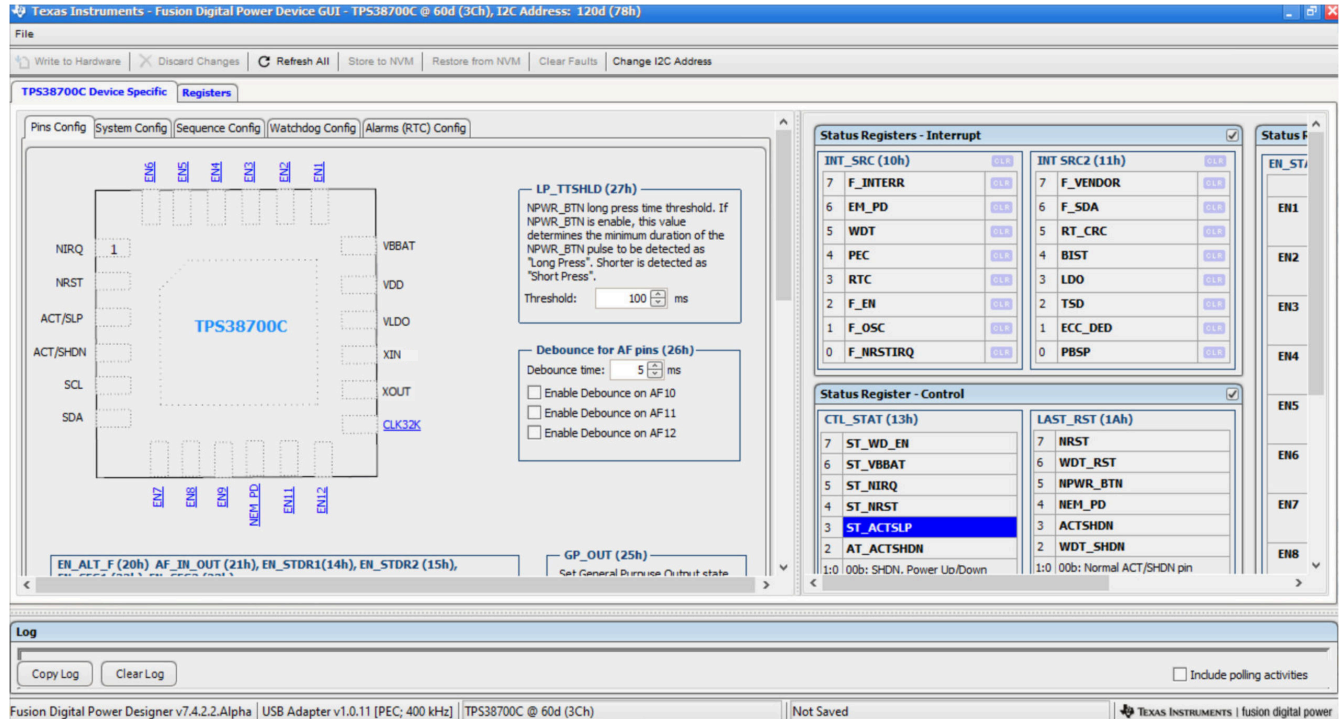


Figure 4-9. Main GUI Screen

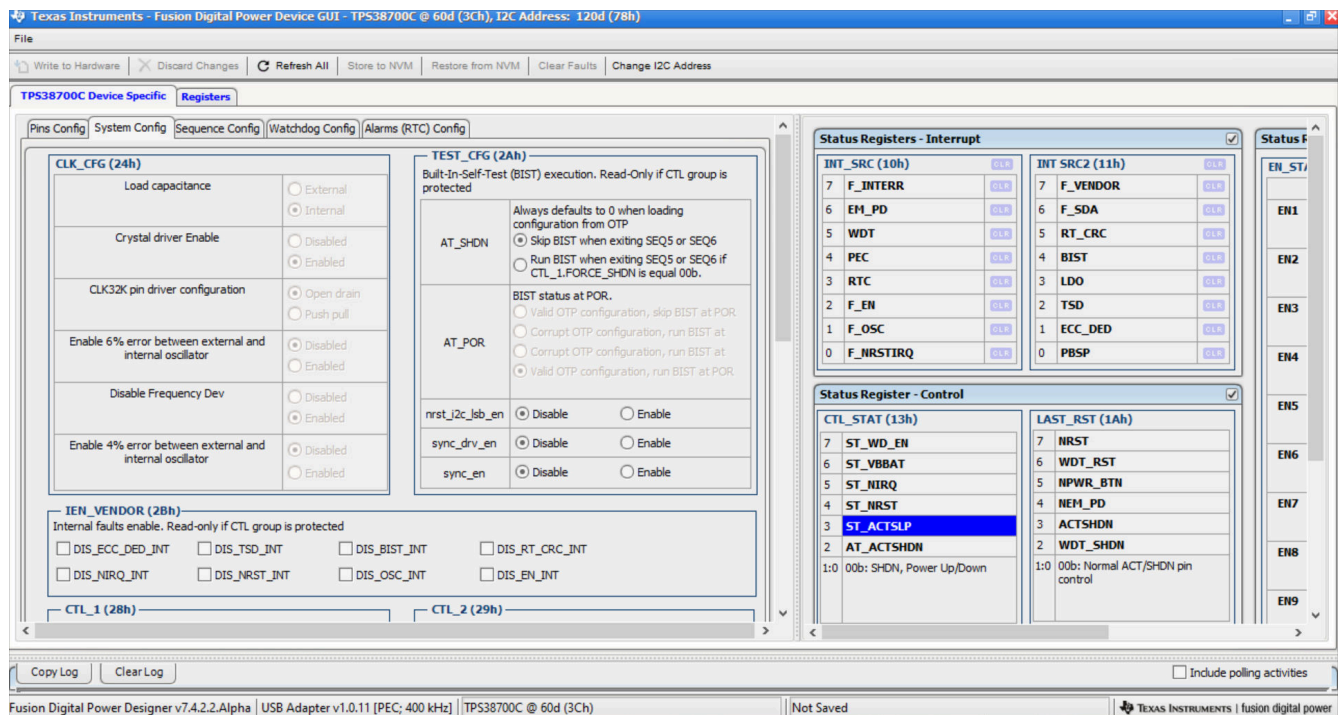


Figure 4-10. System Config

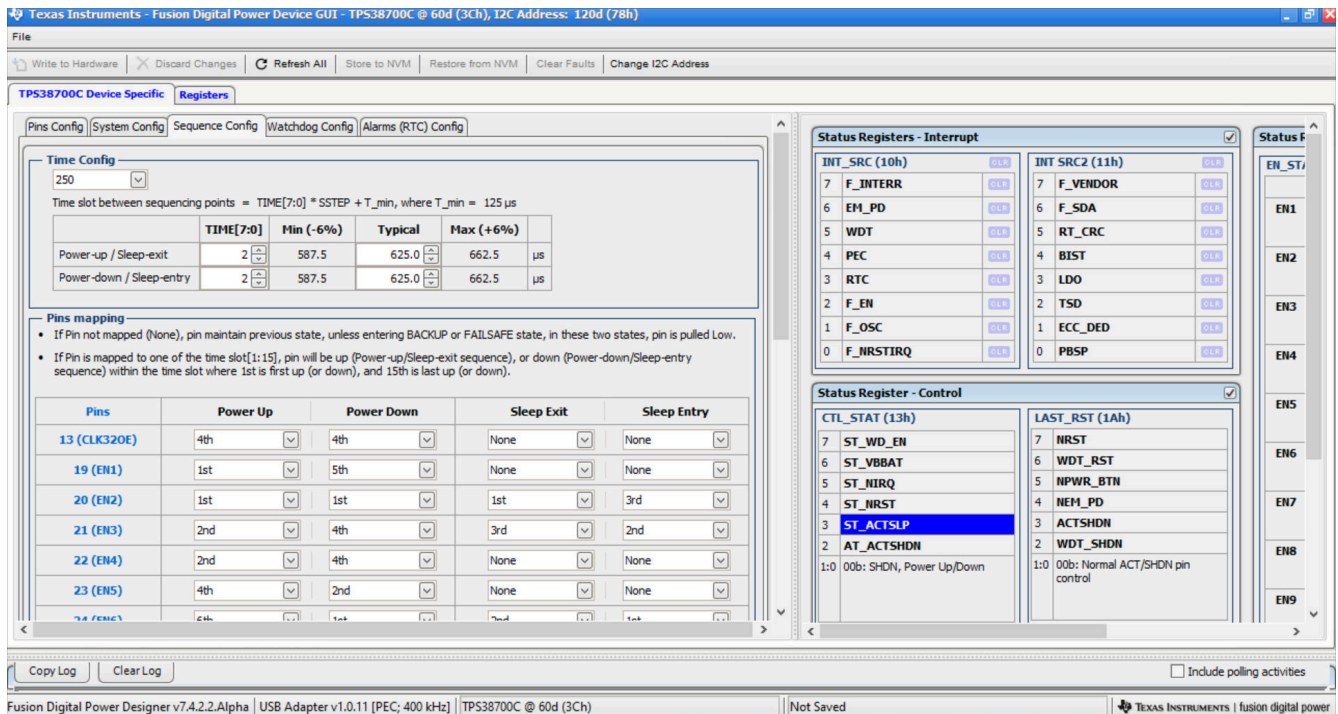


Figure 4-11. Sequence Config

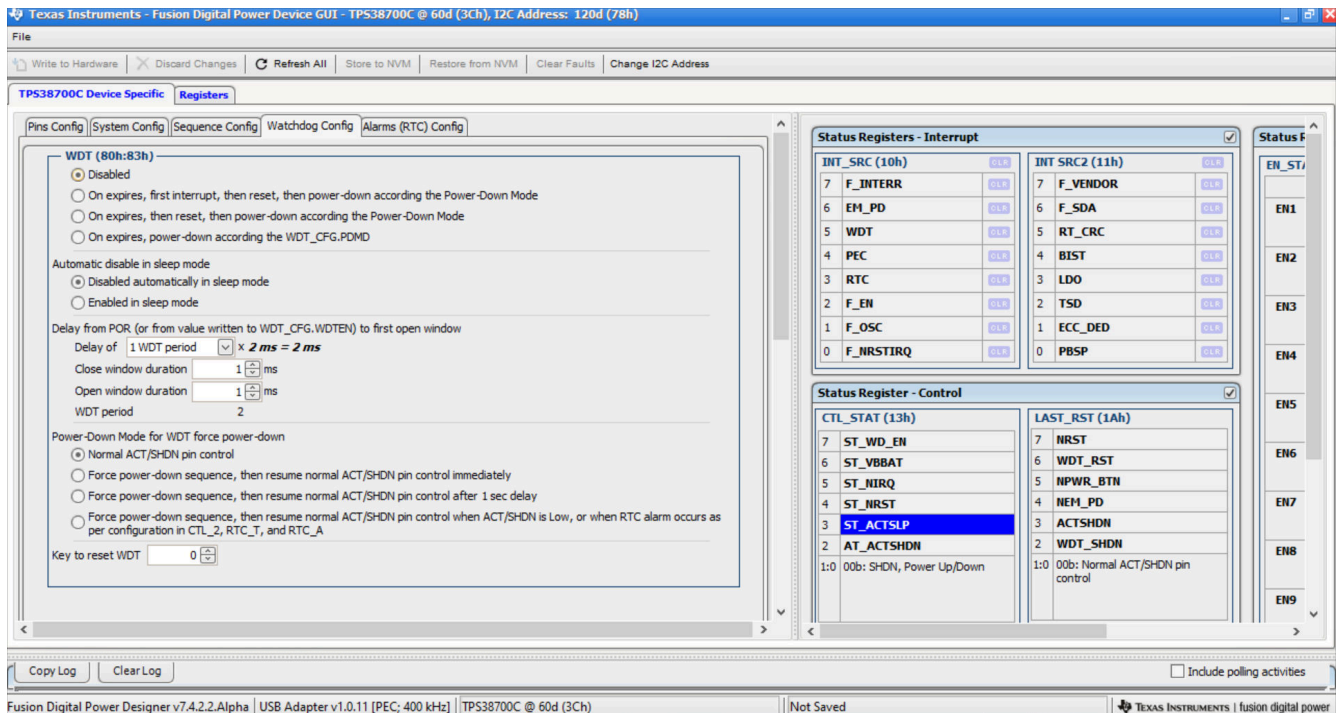


Figure 4-12. Watchdog Config

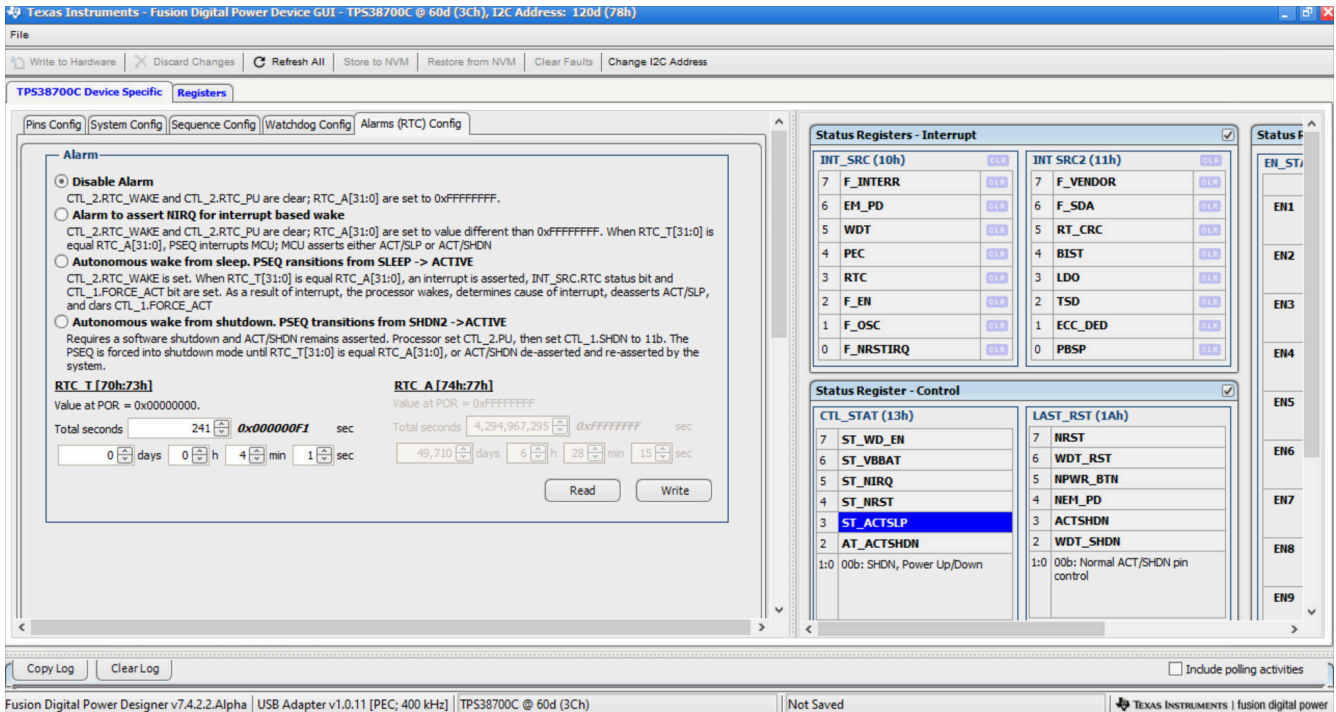


Figure 4-13. Alarms Config

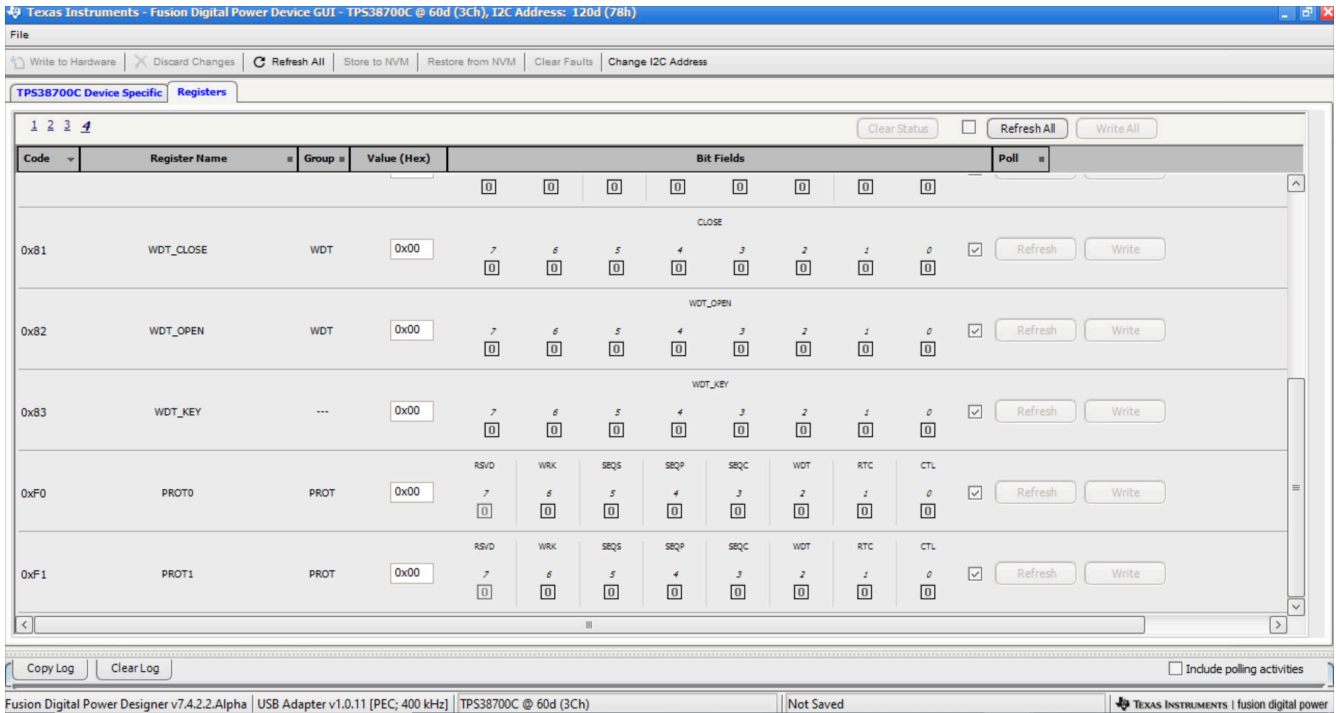


Figure 4-14. Registers

4.3 Quick Start

Follow the steps below precisely to quickly evaluate the TPS38700-Q1. In this quick start, we will be looking at Enable 1 and Enable 2 signals after the ACT pin is triggered.

1. Make the connections described in [Section 4.1](#). Skip the GUI installation if the TPS38700Q1EVM GUI is already installed.
2. Power the EVM by turning on the power supply. Note that the voltage and current at the supply are 3.3 V and 10 mA.
3. Once the TI's USB Interface Adapter is connected to EVM and the laptop, launch the evaluation software Fusion Digital Power Designer.
4. Click on I2C GUI in the bottom right.

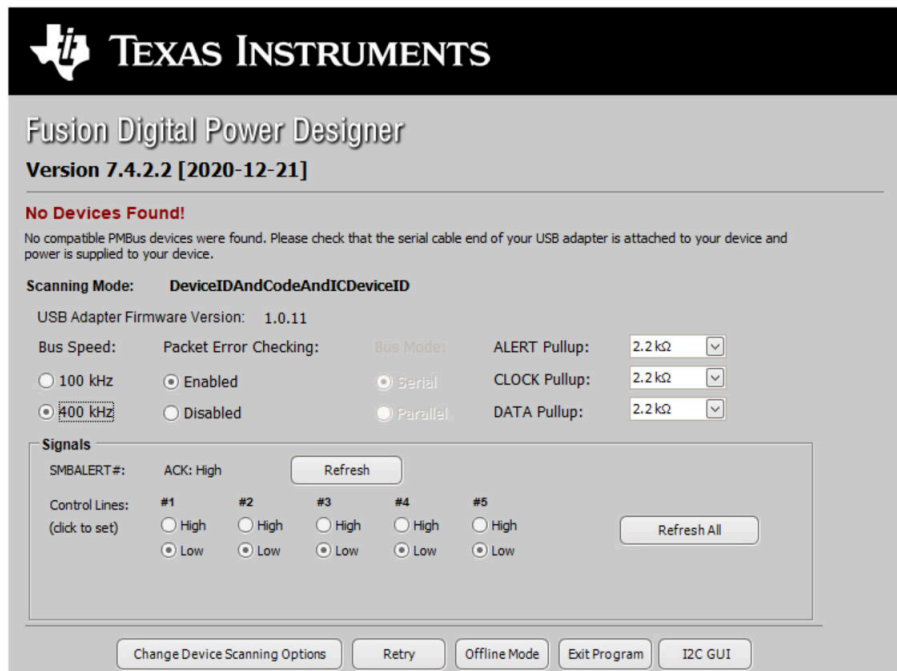


Figure 4-15. Fusion Welcome Window

5. Click on Change Scan Mode to select TPS38700x and then click OK.

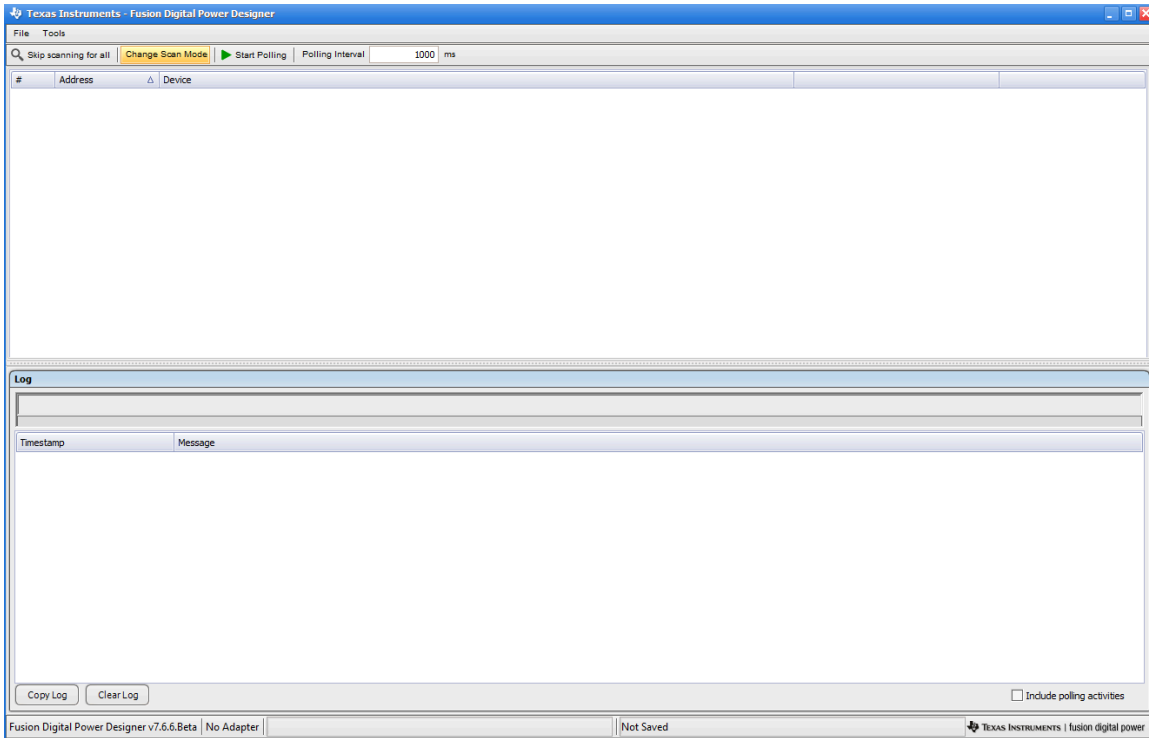


Figure 4-16. Fusion Scan Window

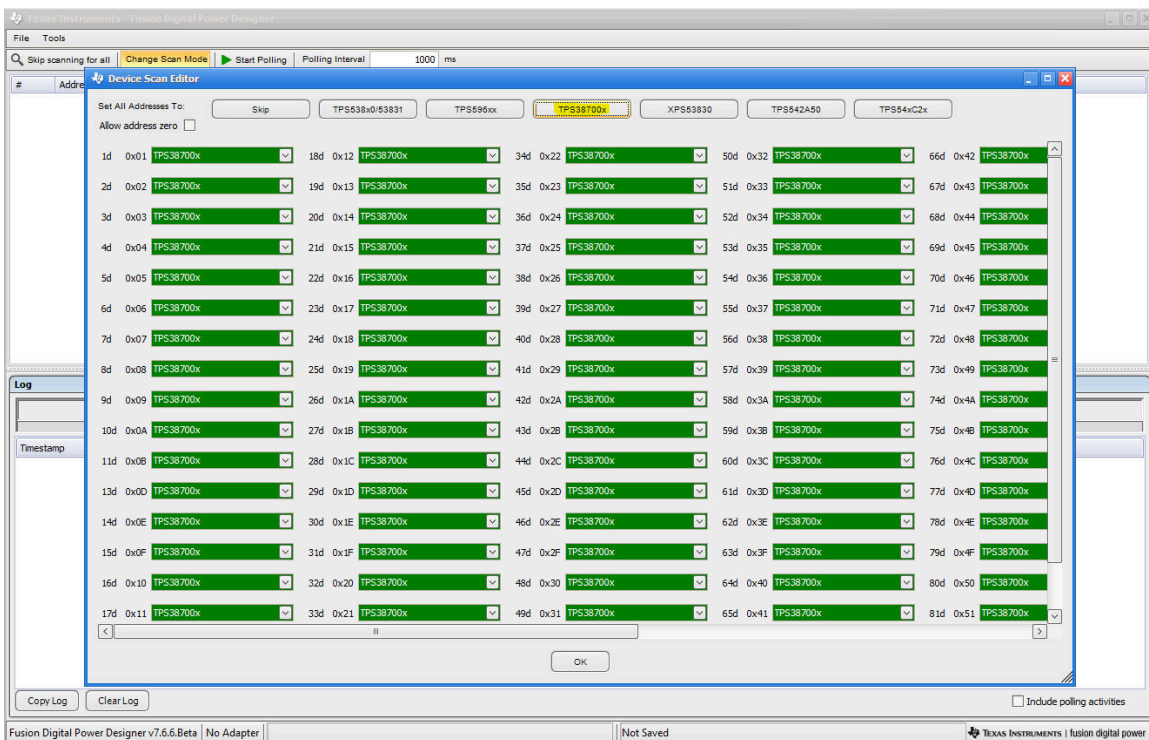


Figure 4-17. Fusion Scan Selection Window

- Scan for the TPS38700Q1EVM by clicking on "Scan for TPS38700x" on top left of the window.

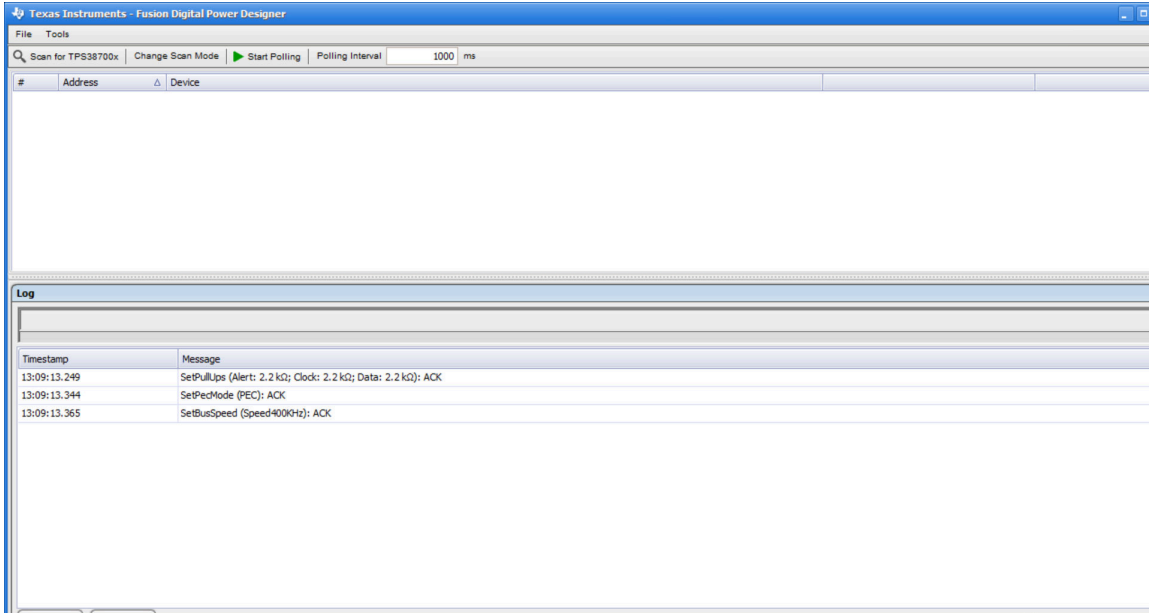


Figure 4-18. Fusion Scan Window - Scanning for TPS38700Q1EVM

- Once the EVM is discovered, select Click to Configure (text in blue).

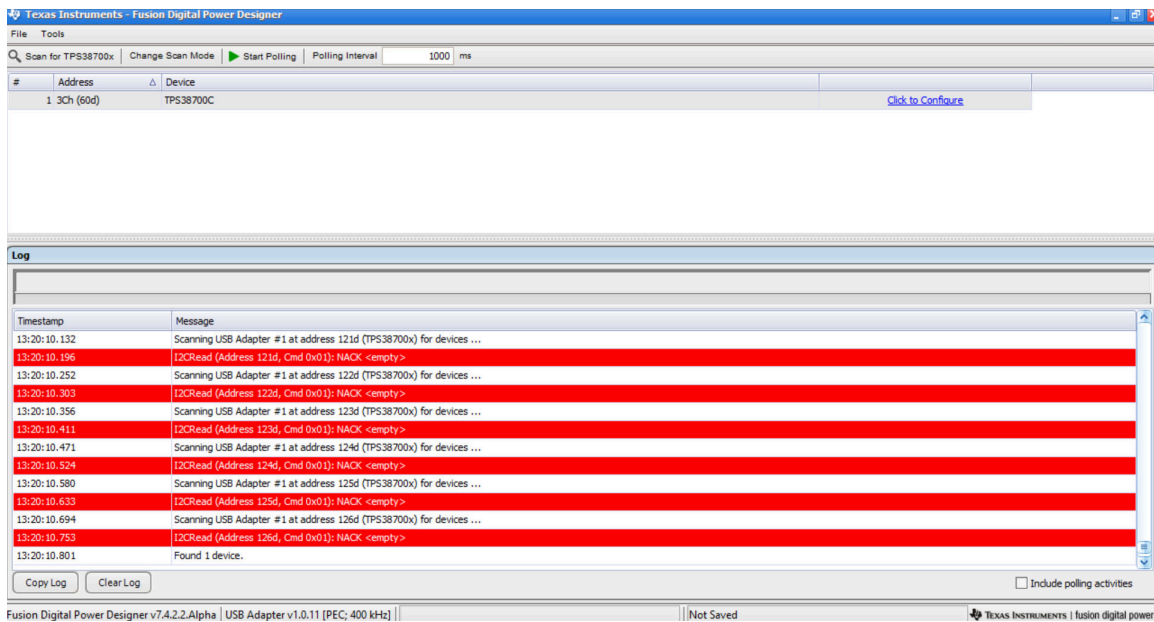


Figure 4-19. Fusion Scan Window - Scan for TPS38700Q1EVM Completed

- Go to the Sequence Config tab. In the Pins mapping section, change the pin 19's (EN1) Power Up sequence from 1st to 4th sequence. Now, the Enable 1 signal is part of the 4th power-up sequence. Hence, delaying the signal by about 2 ms from Enable 2 signal (which is still part of the first power-up sequence).

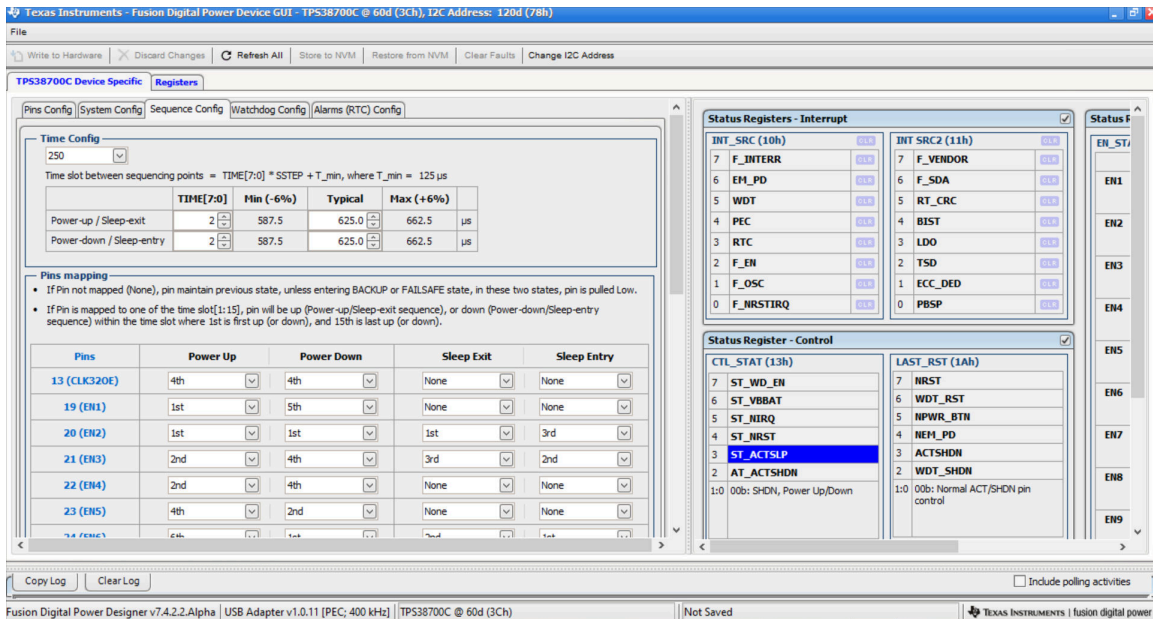


Figure 4-20. TPS38700 GUI Window - Sequence Config Tab

- Change the trigger in the oscilloscope from channel 1 to channel 3 to get the trigger from ACT pin.
- Set the Function Generator to create a 3.3 V pulse waveform. Turn-on the output from the Function Generator connected to the ACT pin to trigger the power-up sequence.
- The output at the oscilloscope should look like the Figure 4-21 where green waveform is the pulse to the ACT pin (TP6), red waveform is Enable 2 signal and blue waveform is the Enable 1 Signal.

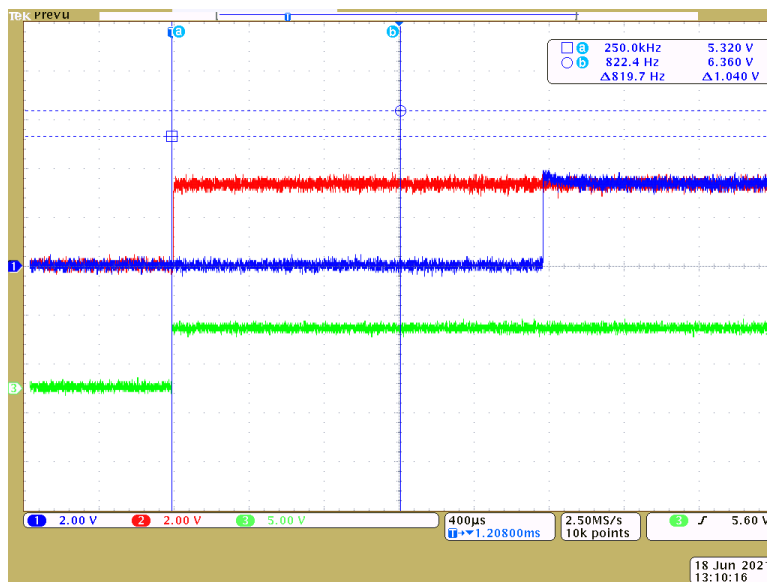


Figure 4-21. Expected Output Signal

5 Revision History

Changes from Revision A (April 2022) to Revision B (July 2023) **Page**

- Update to sequencer part number throughout document..... **3**
-

Changes from Revision * (July 2021) to Revision A (April 2022) **Page**

- Edited the TPS38700Q1EVM Schematic to reflect the new TPS38700-Q1 package pinout..... **6**
 - First public release..... **19**
 - Edited the Main GUI Screen image to reflect the new TPS38700-Q1 package pinout..... **25**
-

STANDARD TERMS FOR EVALUATION MODULES

1. *Delivery:* TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, and/or documentation which may be provided together or separately (collectively, an "EVM" or "EVMs") to the User ("User") in accordance with the terms set forth herein. User's acceptance of the EVM is expressly subject to the following terms.
 - 1.1 EVMs are intended solely for product or software developers for use in a research and development setting to facilitate feasibility evaluation, experimentation, or scientific analysis of TI semiconductors products. EVMs have no direct function and are not finished products. EVMs shall not be directly or indirectly assembled as a part or subassembly in any finished product. For clarification, any software or software tools provided with the EVM ("Software") shall not be subject to the terms and conditions set forth herein but rather shall be subject to the applicable terms that accompany such Software
 - 1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.
2. *Limited Warranty and Related Remedies/Disclaimers:*
 - 2.1 These terms do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.
 - 2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for a nonconforming EVM if (a) the nonconformity was caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI, (b) the nonconformity resulted from User's design, specifications or instructions for such EVMs or improper system design, or (c) User has not paid on time. Testing and other quality control techniques are used to the extent TI deems necessary. TI does not test all parameters of each EVM. User's claims against TI under this Section 2 are void if User fails to notify TI of any apparent defects in the EVMs within ten (10) business days after delivery, or of any hidden defects with ten (10) business days after the defect has been detected.
 - 2.3 TI's sole liability shall be at its option to repair or replace EVMs that fail to conform to the warranty set forth above, or credit User's account for such EVM. TI's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by TI and that are determined by TI not to conform to such warranty. If TI elects to repair or replace such EVM, TI shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.

WARNING

Evaluation Kits are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems.

User shall operate the Evaluation Kit within TI's recommended guidelines and any applicable legal or environmental requirements as well as reasonable and customary safeguards. Failure to set up and/or operate the Evaluation Kit within TI's recommended guidelines may result in personal injury or death or property damage. Proper set up entails following TI's instructions for electrical ratings of interface circuits such as input, output and electrical loads.

NOTE:

EXPOSURE TO ELECTROSTATIC DISCHARGE (ESD) MAY CAUSE DEGRADATION OR FAILURE OF THE EVALUATION KIT; TI RECOMMENDS STORAGE OF THE EVALUATION KIT IN A PROTECTIVE ESD BAG.

3 Regulatory Notices:

3.1 United States

3.1.1 Notice applicable to EVMs not FCC-Approved:

FCC NOTICE: This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

3.3 Japan

3.3.1 *Notice for EVMs delivered in Japan:* Please see http://www.tij.co.jp/lstds/ti_ja/general/eStore/notice_01.page 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。

<https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-delivered-in-japan.html>

3.3.2 *Notice for Users of EVMs Considered "Radio Frequency Products" in Japan:* EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

【無線電波を送信する製品の開発キットをお使いになる際の注意事項】 開発キットの中には技術基準適合証明を受けていないものがあります。技術適合証明を受けていないものご使用に際しては、電波法遵守のため、以下のいずれかの措置を取っていただく必要がありますのでご注意ください。

1. 電波法施行規則第6条第1項第1号に基づく平成18年3月28日総務省告示第173号で定められた電波暗室等の試験設備でご使用いただく。
2. 実験局の免許を取得後ご使用いただく。
3. 技術基準適合証明を取得後ご使用いただく。

なお、本製品は、上記の「ご使用にあたっての注意」を譲渡先、移転先に通知しない限り、譲渡、移転できないものとします。

上記を遵守頂けない場合は、電波法の罰則が適用される可能性があることをご留意ください。日本テキサス・イ

ンスツルメンツ株式会社

東京都新宿区西新宿 6 丁目 2 4 番 1 号

西新宿三井ビル

3.3.3 *Notice for EVMs for Power Line Communication:* Please see http://www.tij.co.jp/lstds/ti_ja/general/eStore/notice_02.page

電力線搬送波通信についての開発キットをお使いになる際の注意事項については、次のところをご覧ください。 <https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-for-power-line-communication.html>

3.4 European Union

3.4.1 *For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive):*

This is a class A product intended for use in environments other than domestic environments that are connected to a low-voltage power-supply network that supplies buildings used for domestic purposes. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

-
- 4 *EVM Use Restrictions and Warnings:*
 - 4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.
 - 4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.
 - 4.3 *Safety-Related Warnings and Restrictions:*
 - 4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.
 - 4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.
 - 4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.
 5. *Accuracy of Information:* To the extent TI provides information on the availability and function of EVMs, TI attempts to be as accurate as possible. However, TI does not warrant the accuracy of EVM descriptions, EVM availability or other information on its websites as accurate, complete, reliable, current, or error-free.
 6. *Disclaimers:*
 - 6.1 EXCEPT AS SET FORTH ABOVE, EVMS AND ANY MATERIALS PROVIDED WITH THE EVM (INCLUDING, BUT NOT LIMITED TO, REFERENCE DESIGNS AND THE DESIGN OF THE EVM ITSELF) ARE PROVIDED "AS IS" AND "WITH ALL FAULTS." TI DISCLAIMS ALL OTHER WARRANTIES, EXPRESS OR IMPLIED, REGARDING SUCH ITEMS, INCLUDING BUT NOT LIMITED TO ANY EPIDEMIC FAILURE WARRANTY OR IMPLIED WARRANTIES OF MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF ANY THIRD PARTY PATENTS, COPYRIGHTS, TRADE SECRETS OR OTHER INTELLECTUAL PROPERTY RIGHTS.
 - 6.2 EXCEPT FOR THE LIMITED RIGHT TO USE THE EVM SET FORTH HEREIN, NOTHING IN THESE TERMS SHALL BE CONSTRUED AS GRANTING OR CONFERRING ANY RIGHTS BY LICENSE, PATENT, OR ANY OTHER INDUSTRIAL OR INTELLECTUAL PROPERTY RIGHT OF TI, ITS SUPPLIERS/LICENSORS OR ANY OTHER THIRD PARTY, TO USE THE EVM IN ANY FINISHED END-USER OR READY-TO-USE FINAL PRODUCT, OR FOR ANY INVENTION, DISCOVERY OR IMPROVEMENT, REGARDLESS OF WHEN MADE, CONCEIVED OR ACQUIRED.
 7. *USER'S INDEMNITY OBLIGATIONS AND REPRESENTATIONS.* USER WILL DEFEND, INDEMNIFY AND HOLD TI, ITS LICENSORS AND THEIR REPRESENTATIVES HARMLESS FROM AND AGAINST ANY AND ALL CLAIMS, DAMAGES, LOSSES, EXPENSES, COSTS AND LIABILITIES (COLLECTIVELY, "CLAIMS") ARISING OUT OF OR IN CONNECTION WITH ANY HANDLING OR USE OF THE EVM THAT IS NOT IN ACCORDANCE WITH THESE TERMS. THIS OBLIGATION SHALL APPLY WHETHER CLAIMS ARISE UNDER STATUTE, REGULATION, OR THE LAW OF TORT, CONTRACT OR ANY OTHER LEGAL THEORY, AND EVEN IF THE EVM FAILS TO PERFORM AS DESCRIBED OR EXPECTED.

8. *Limitations on Damages and Liability:*

8.1 *General Limitations.* IN NO EVENT SHALL TI BE LIABLE FOR ANY SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL, OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF THESE TERMS OR THE USE OF THE EVMS , REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES. EXCLUDED DAMAGES INCLUDE, BUT ARE NOT LIMITED TO, COST OF REMOVAL OR REINSTALLATION, ANCILLARY COSTS TO THE PROCUREMENT OF SUBSTITUTE GOODS OR SERVICES, RETESTING, OUTSIDE COMPUTER TIME, LABOR COSTS, LOSS OF GOODWILL, LOSS OF PROFITS, LOSS OF SAVINGS, LOSS OF USE, LOSS OF DATA, OR BUSINESS INTERRUPTION. NO CLAIM, SUIT OR ACTION SHALL BE BROUGHT AGAINST TI MORE THAN TWELVE (12) MONTHS AFTER THE EVENT THAT GAVE RISE TO THE CAUSE OF ACTION HAS OCCURRED.

8.2 *Specific Limitations.* IN NO EVENT SHALL TI'S AGGREGATE LIABILITY FROM ANY USE OF AN EVM PROVIDED HEREUNDER, INCLUDING FROM ANY WARRANTY, INDEMNITY OR OTHER OBLIGATION ARISING OUT OF OR IN CONNECTION WITH THESE TERMS, , EXCEED THE TOTAL AMOUNT PAID TO TI BY USER FOR THE PARTICULAR EVM(S) AT ISSUE DURING THE PRIOR TWELVE (12) MONTHS WITH RESPECT TO WHICH LOSSES OR DAMAGES ARE CLAIMED. THE EXISTENCE OF MORE THAN ONE CLAIM SHALL NOT ENLARGE OR EXTEND THIS LIMIT.

9. *Return Policy.* Except as otherwise provided, TI does not offer any refunds, returns, or exchanges. Furthermore, no return of EVM(s) will be accepted if the package has been opened and no return of the EVM(s) will be accepted if they are damaged or otherwise not in a resalable condition. If User feels it has been incorrectly charged for the EVM(s) it ordered or that delivery violates the applicable order, User should contact TI. All refunds will be made in full within thirty (30) working days from the return of the components(s), excluding any postage or packaging costs.

10. *Governing Law:* These terms and conditions shall be governed by and interpreted in accordance with the laws of the State of Texas, without reference to conflict-of-laws principles. User agrees that non-exclusive jurisdiction for any dispute arising out of or relating to these terms and conditions lies within courts located in the State of Texas and consents to venue in Dallas County, Texas. Notwithstanding the foregoing, any judgment may be enforced in any United States or foreign court, and TI may seek injunctive relief in any United States or foreign court.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2023, Texas Instruments Incorporated

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#), [TI's General Quality Guidelines](#), or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2026, Texas Instruments Incorporated

Last updated 10/2025